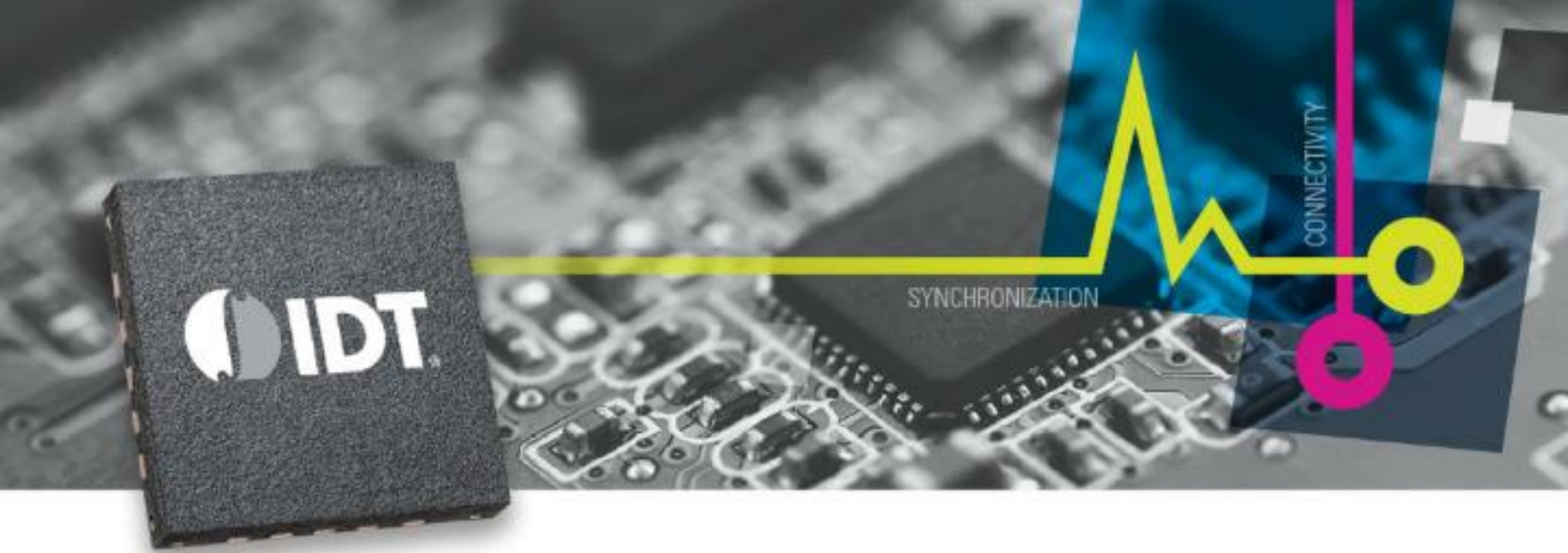




IDT Sensors Presentation

Oct 2018

IDT Sensors

- Best in class signal conditioning ICs (ASSPs and ASICs) for automotive and industrial sensor markets
- Select market solutions for integrated sensor products (Environmental and Medical)
- Automotive Grade Solutions (supporting Functional Safety)

Position Sensor



Inductive Position sensor

- ✓ Robust against dust and vibration
- ✓ One technology for on-off-axis, linear, low and high speed
- ✓ Stray field immunity

SSC Products



Sensor signal conditioner products are suitable for:

- ✓ Pressure sensor
- ✓ Torque
- ✓ Temperature
- ✓ Humidity
- ✓ Weight / load

Gas Sensors



TVOC and CO2 sensing solution for indoor air quality:

- ✓ Bathroom
- ✓ Kitchen
- ✓ Bedroom
- ✓ Office

IoT Sensing



- ✓ Flow sensor
- ✓ Humidity and Temperature sensor



Digital Mass Flow Sensor Family

FS1012 / FS2012

General Types of Flow Meters

- **Mass Flow**

- Measures Mass Flow Rate of the Fluid
- **Thermal** or Coriolis Force
- Good at Gases (e.g. Chemical Reactions) other Meters Cannot Measure

- Differential Pressure

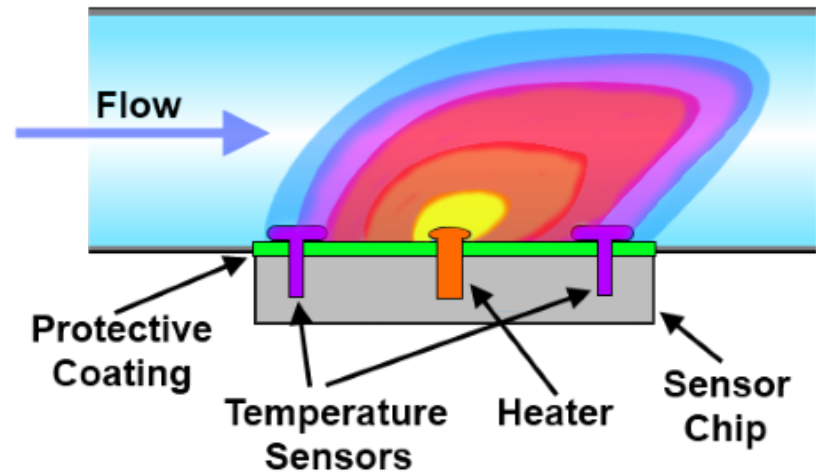
- Measures Drop in Pressure Across a Constriction
- Accounts for up to 20% of World's Market Use

- Velocity

- Measures Velocity of Stream
- Ultrasonic, Electromagnetic, Paddlewheel

- Positive Displacement

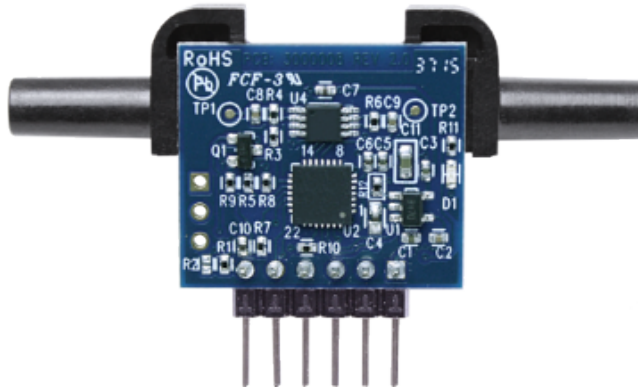
- Mechanical Systems that Measure Actual Flow of Fluid
- Rotary Vane, Gear Types, Rotating Disk, etc.



Example of a thermal mass flow meter
(constant temperature differential)

**IDT Flow sensors utilize
thermopile sensing!**

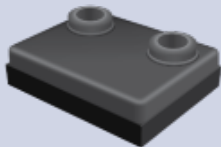
Mass Flow Sensor Product Family



- These devices are IDT's first standard products offering porous silicon technology for the sense element
 - MEMS "solid-state" mass Flow sensor
- The Flow sensors are designed for broad market applications including medical and beverage industries
- IDT Flow sensors' strong distinctions
 - High performance solid-state MEMS Flow sensor module for liquids and gases

Flow Sensor Family

Different Integration Levels

Solution	Packaged MEMS	MEMS Sensor on PCB	MEMS Sensor with on-board circuit	
	Analog output 	Analog output 	Analog Output Non-calibrated 	Analog + Digital output Fully calibrated 
Support level	High	High	Low	Low
Integration effort	High	High	Low	Low
ASP	Low	Medium	Low	High
Product	FS3000 *	FS1012	FS102x	FS2012

* Roadmap

FS1012/2012 Product Overview

High Performance Solid-State MEMS Flow Sensor Module for Liquids and Gases

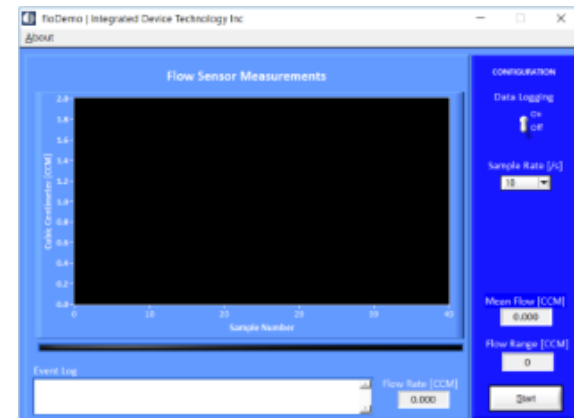
Features

- MEMS Thermopile sensing
- Silicon-carbide coating over MEMS Flow sensor
- 3V to 5V supply (5V for FS2012)
- Analog output, 0V to 5V (FS2012)
- Digital Output, I2C (FS2012)
- Small and compact module footprint
- Flexible product versions
 - Raw sensor voltage output (FS1012)
 - Fully calibrated and compensated Flow for gas or liquid (FS2012)

Benefits

- Suitable for gas and liquid
- Robust solid isolation technology
- No cavity in MEMS element to cause clogging
- Resistant to vibration and pressure shock
- High temperature Flow housing
- Food-grade compatible version
- Typical 8ms Fast Response Time
- High sensitivity
- Easy cleaning and sterilization

Flexible Flow Sensor Solutions with Easy-to-Use Evaluation Software



Status	Released product
Availability	Samples available now
Production	October 1, 2017

Flow Sensor Technology Comparison

IDT “Solid State” MEMS	Competitor A Thermal-based	Competitor B Thermal-based
✓ Solid Silicon Thermal Isolation	✗ Thin Membrane over Cavity (Fragile)	✗ Thin Membrane over Cavity (Fragile)
✓ Resistant to water condensation, Particles, Pressure Shock/Vibration	✗ RTD Sensing (Noisy)	✗ RTD Sensing (Noisy)
✓ Easy cleaning and sterilization	✗ Wire-Bonds not Protected	✗ Cannot be Cleaned
✓ Thermopile Sensing (Low Noise)		✗ Attract Fuel Vapor Contamination/Particles
✓ Low Operating Temperature		

Flow Sensor Performance Comparison

	IDT	Competitor
MEMS Sensor	• Utilize Thermopile Sensing • High Signal-to-Noise	• RTD • Low Signal-to-Noise
Accuracy	• 2% of reading (typical)	• ~5% Full Scale
Robustness	• Resistant to Particles • Vibration and Pressure Shock Resistant	• Particles or Water Condensation will Damage the Micro-bridge Sensing Element • Mechanical & Pressure Shock will Damage Sensing Element
Output	• Analog or Digital • Linear • Custom	• Non-Linear
Supply Voltage	• 3 to 5V	• $\geq 5V$

Markets and Applications

Industrial Process Applications

- Process
- Oil and gas leak detection
- HVAC and air-control systems
- White Goods (home appliance)
- Liquid dispensing and metering systems
- Air speed and wind meter

Medical/Healthcare Applications

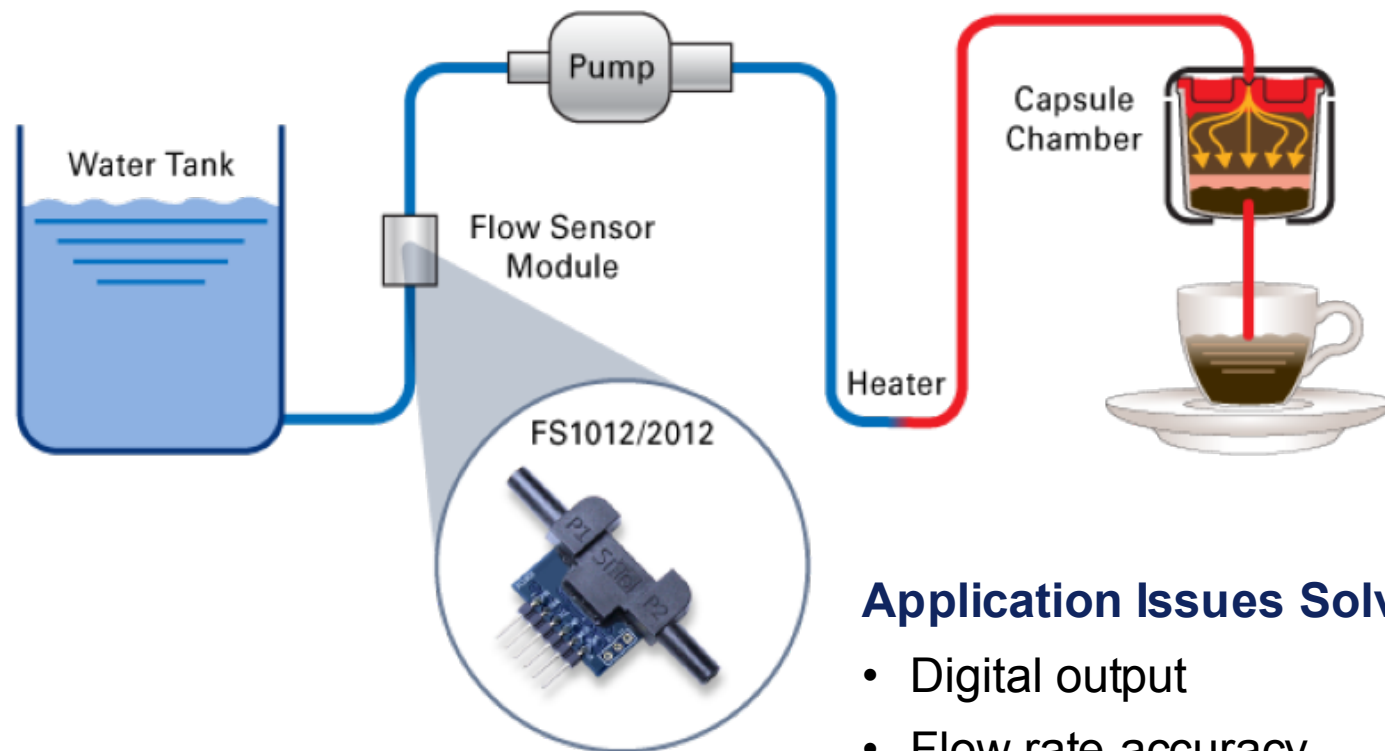
- Medical
- Oxygen canals
- CPAP (continuous positive airway pressure) and respiratory devices
- Breathalyzer

Automotive Applications

- Mass
- Diesel fuel flow
- Brake fluid Flow
- Cabin air quality

Application Example

Beverages: Coffee Machines



Application Issues Solved

- Digital output
- Flow rate accuracy
- Cleanable device

Application Example

Beverages: Fountain Drink Dispenser



Application Issues Solved

- Digital output
- Flow rate accuracy
- Cleanable device



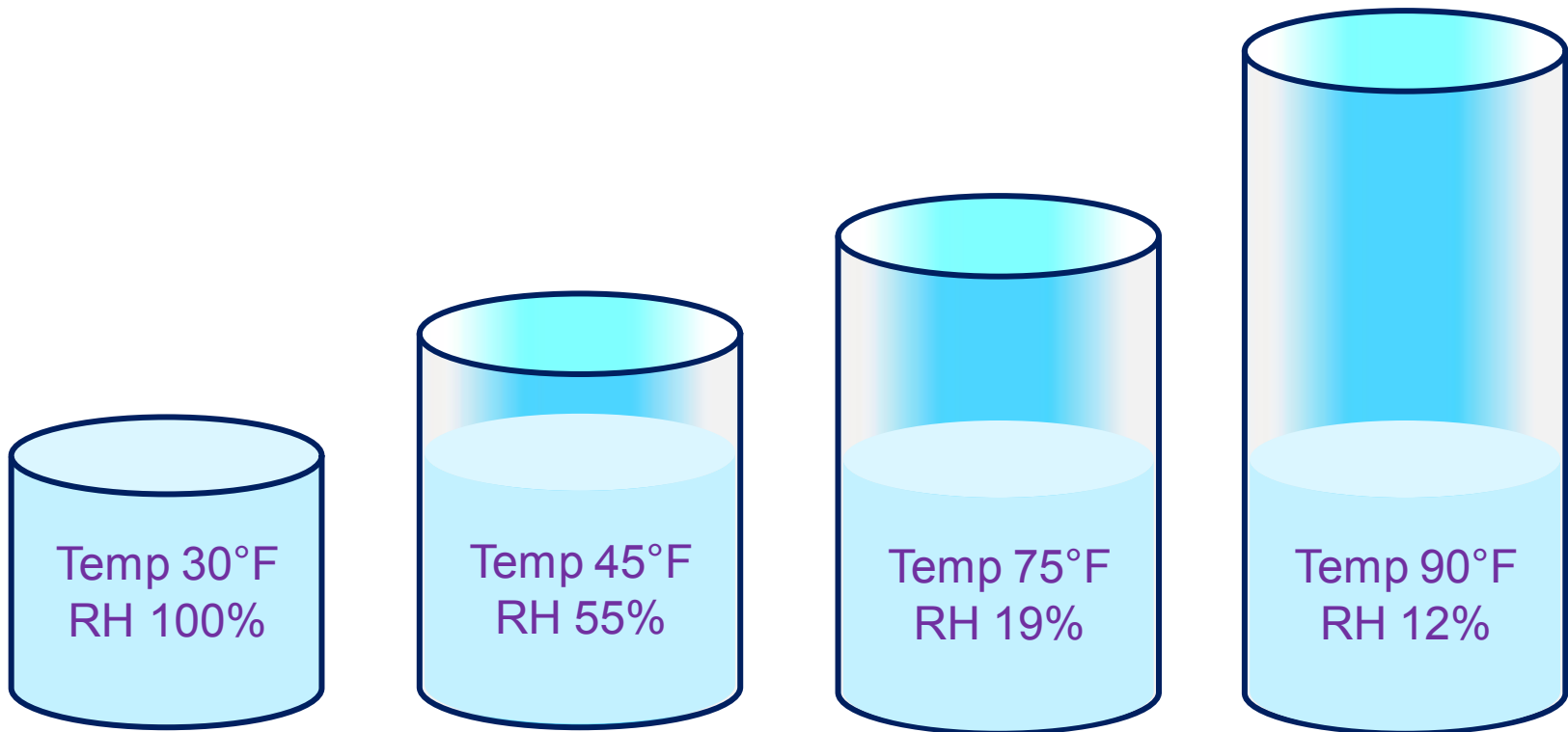
HS300x

Understanding Relative Humidity Sensors and Applications

What is Relative Humidity?

- Humidity is moisture or water vapor in air or gases
- RH is the ratio between the amount of water vapor (moisture) in the air at a given temperature to the maximum amount of water vapor the air can hold at that temperature; expressed in %
- RH is relative to the temperature at that moment
- Warm temperature can hold more moisture than cold temperature
- Dew Point is a better indicator for “how comfortable the air feels”, it is equal to or lower than ambient temperature
- Absolute Humidity is independent of temperature, 30grams/m³ at 35°C

Example of RH Changes with Temperature



Types of RH Sensor

- Capacitive
 - Change in dielectric of a polymer based material
 - CMOS processing compatible
- Resistive
 - Ions through conductive polymer film or salt changes the impedance of an inter-digit electrodes
 - Tradition thick film on ceramic substrate using noble metal as electrodes
- Thermal Conductivity
 - Absolute humidity

Key Parameters

- Accuracy
 - Less than $\pm 2\%RH$ is high precision
 - $\pm 1\%RH$ are calibration chamber units; 7% to 80%RH at 18°C to 23°C
- Long-Term Stability
 - %RH Drift per year
- Response Time
 - In seconds, initial value to 63% of total variation
- Environmental and Chemical Resistance
 - Effects from airborne contamination

Market Segment & Applications

Consumer	White Goods	Industrial	Medical
• Thermostats • Printers • Mobile Devices	• Microwave Oven • Dryer • Refrigerator	• Home Appliances • Air Quality Monitoring • Weather Stations • HVAC, Air-Control Systems • Food Safety	• Gas Quality • Laboratory Equipment • Respiratory Equipment • Incubators • Sterilizers • Drug Processing
			

HS300x Product Overview

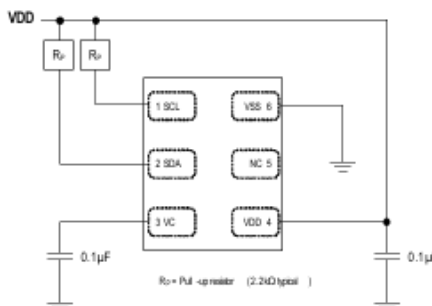
- **Features:**

- Silicon carbide structure
- $\pm 1.5\%$ RH accuracy (HS3001)
- Fast RH response time (Typ. 6 seconds)
- 0.1% RH/Yr drift
- 14-bit resolution: 0.01% RH (Typ.)
- Low power consumption: $1.0\mu\text{A}$ average
- Digital output
- Extended supply voltage: 2.3V to 5.5V
- $3.0 \times 2.41 \times 0.8$ mm LGA
- Product family approach for varied accuracy levels

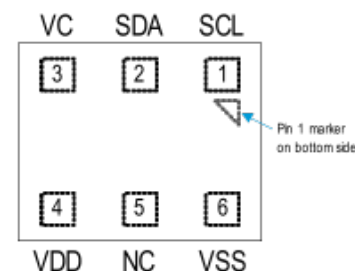
- **Benefits:**

- Integrated temperature and humidity sensing solution
 - o Small form factor solution with lower system cost
- Low power consumption saves battery
- 14-bit high resolution provides extremely tight accuracy
- Insensitive to environmental contaminants like dirt and dust
- Small size solution saves space & BOM for compact designs
- On board calibration reduces time to market
- Wide supply voltage range eliminates the need for LDO/DC-DC

Application Circuit



Pin-Out Diagram



HS300x Product Family

Device	Relative Humidity	Temperature
HS3001	±1.5%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA	-40°C to +125°C
HS3002	±1.8%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA	-40°C to +125°C
HS3003	±2.8%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA	-40°C to +125°C
HS3004	±3.8%RH (Typical), 3.0 × 2.41 × 0.8 mm, 6-LGA	-40°C to +125°C

Competitive Price-to-Performance Value Product Family Choices

HS300x Competitive Advantages

- Silicon-Carbide structure sensor technology
 - Capacitive sensing
 - Very high strength and reliability
 - Low drift, excellent stability against aging
 - Highly resistant to chemicals

Supplier	Accuracy	Response Time	Long-Term Stability	Size (mm)
IDT HS3001	±1.5%RH, ±1.8%RH max	6 seconds	0.1%RH/Yr.	3 × 2.4 × 0.8
Sensirion SHT35	±1.5%RH, ±2.0%RH max	8 seconds	0.25%RH/Yr.	2.5 × 2.5 × 0.9
TI HDC2010	±2.0%RH	8 seconds	0.25%RH/Yr.	1.5 × 1.5 × 0.675 (CSP)
Silabs Si7013	±3.0%RH	17 seconds	0.25%RH/Yr.	3.0 × 3.0 × 0.75

IDT Value Proposition:

Accuracy, response time and ultra-low power consumption along with long-term stability.

Sales & Design Collateral

MARKETING COLLATERAL

- Sales presentation: Saleslink
- Product overview: IDT.COM website
- Product video: IDT.COM website

DESIGN DOCUMENTATION

- Datasheet: IDT website
- Evaluation board manual: IDT website

OTHER INFO

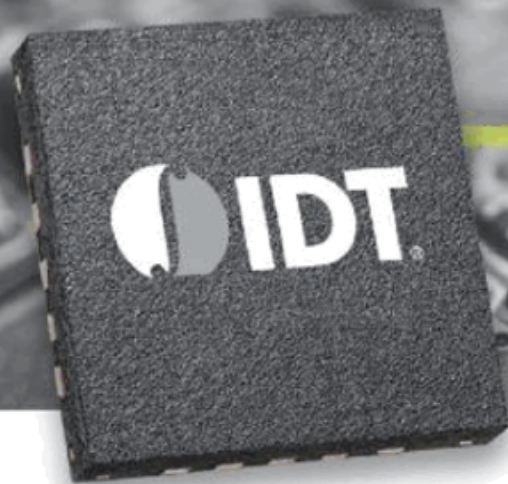
- Evaluation Kits: SDAH01, SDAH02, SDAWIR01/02
- Blog: IDT.com/blogs





Thank You

Analog Mixed Signal Product
Leadership in Growth Markets



SYNCHRONIZATION

CONNECTIVITY

IDT Inductive Position Sensors

2018.10.24 | Andy Tan | IDT AIG



Content

- Marketing and technical background
 - Position sensor solutions & comparing
 - Target markets and applications
- Inductive position sensing technology
 - Eddy current effect
 - Signal conditioning block and flowing
 - Key parameters and Application tips
- EVK introduction (help to start ZMID520X)

ZMID520x

Inductive Position Sensors



Marketing and technical background

What is a Position Sensor?

Position
Sensor

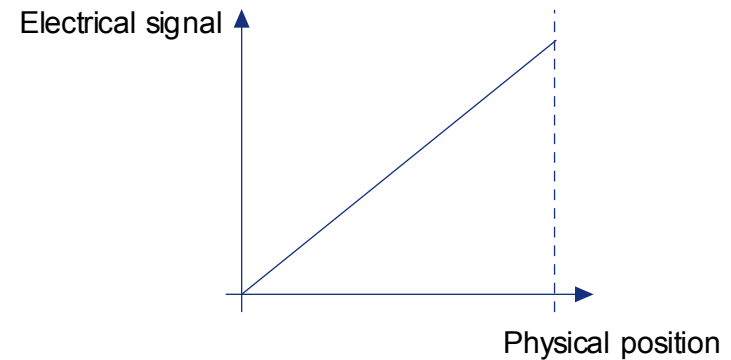
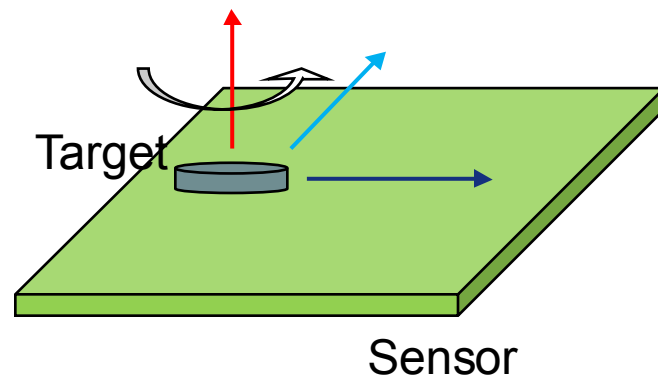


Position Measurement

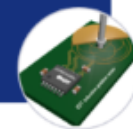
Physical Position



Electrical signal or quantity

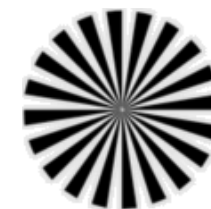
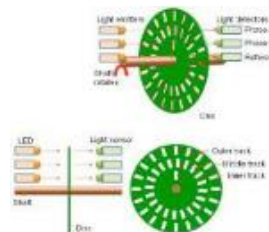
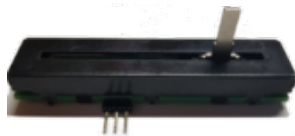
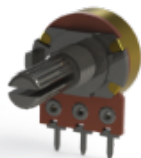


Position Sensor



Contactless

Optical



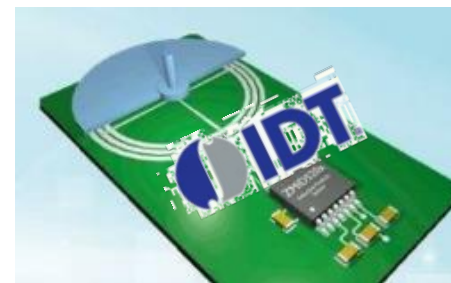
Magnetic

On-off rotary



Up-down rotary switches

Inductive



Contactless Position Sensors

Position
Sensor



Optical

- Excellent linearity & resolution
- Low cost (not always)

- Sensitive to high temperature, humidity, vibration and dust
- Bulky
- Incremental, not absolute

Magnetic

- Physically scalable
- Robust against dust and vibration

- Need magnet as target (\$\$)
- Hard to achieve long stroke (linear applications)
- No absolute off-axes high speed

Resolvers

- Robust
- Excellent linearity

- Bulky
- expensive

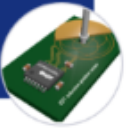
Inductive

- No magnet needed (\$↓)
- Robust against dust and vibration
- One technology for **on- off-axis**, linear, low and **high speed**
- Stray field immunity

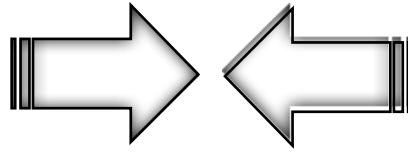
- Hard to miniaturize
- PCB coil design know how needed

Which is the right sensor?

Position
Sensor



Contact



Contactless



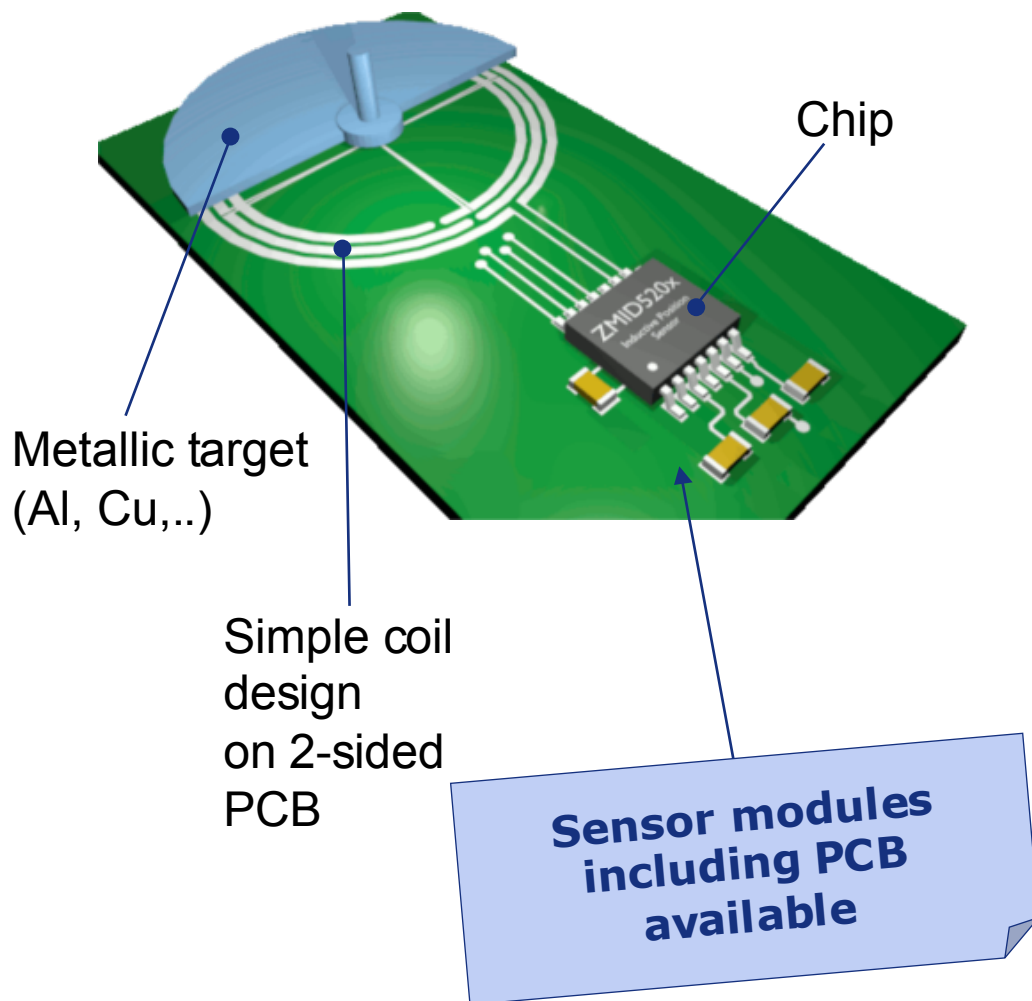
Flexibility



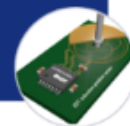
PLUGANDPLAY

IDT Inductive Position Sensors

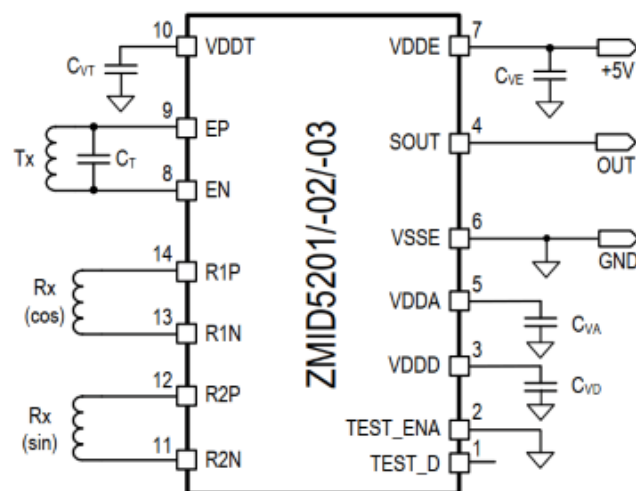
Position
Sensor



- No magnet needed
- Total stray field immunity - ISO 11452-8 compliant
- Ultra-thin solution - Small form factor
- No external sensor chip needed - the sensor is a PCB coil
- Compliant to auto standards - AECQ-100, ESD, EMC
- Suitable for high temperature
- On and off-axis capability and alignment



Application Circuit



Symbol	Parameter	Conditions	Minimum	Maximum	Units
V_{VDDE}	External supply voltage		-18	18	V
V_{OUT_ANA}	ZMID5201 analog output voltage on the AOUT pin ^[a]	For negative voltage, external current must be limited to 10mA	-14	14	V
		Without external current limitation	-0.3	14	V
V_{OUT_PWM}	ZMID5202 PWM output voltage on the PWM OUT pin ^[a]	For negative voltage, external current must be limited to 10mA	-14	18	V
		Without external current limitation	-0.3	18	V
V_{OUT_SENT}	ZMID5203 SENT output voltage on the SENT OUT pin ^[a]	For negative voltage, external current must be limited to 10mA	-14	18	V
		Without external current limitation	-0.3	18	V
V_{OSC_COIL}	Oscillator coil pins: EP, EN		-0.3	5.5	V

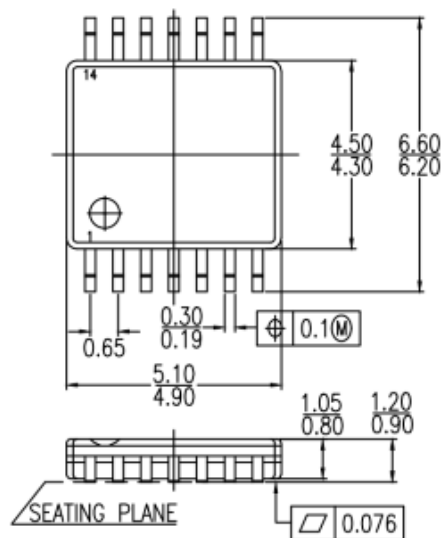


Table 3. Operating Conditions

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
T_{AMB}	Ambient temperature		-40		150	°C
T_J	Junction temperature		-40		175	°C
T_{STOR}	Storage temperature		-50		150	°C
R_{THJA}	Thermal resistance junction to ambient				140	°C/W
V_{VDDE}	Supply voltage		4.5	5	5.5	V
ESD	Electrostatic discharge, HBM 100pF/1.5kΩ	Pins VSS, VCC	±4			kV
		Pin SOUT ^[a]	±3			kV
		All other pins	±2			kV



ZMID520x

Inductive Position Sensors



Application Categories

Application categories

Position
Sensor

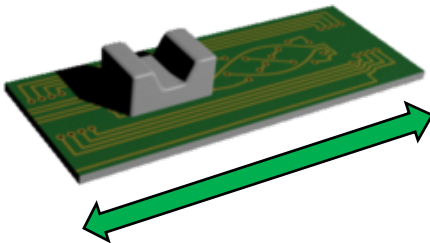


Motor Commutation

Position sensor to
allow motor control

Non-Motor Comm.

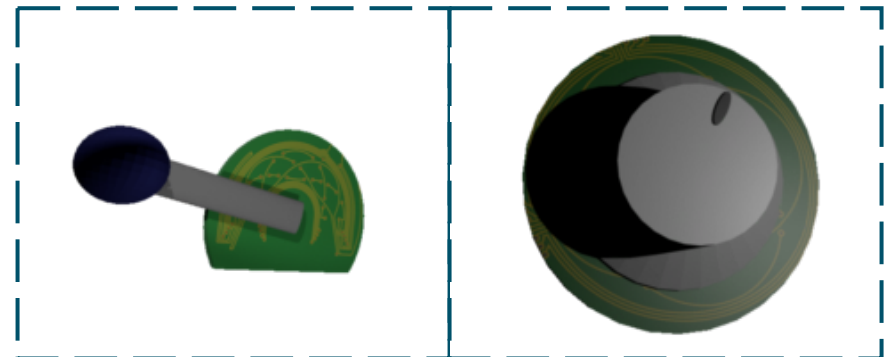
Linear



Rotative

Arc

360° full turn



Typical Linear Applications

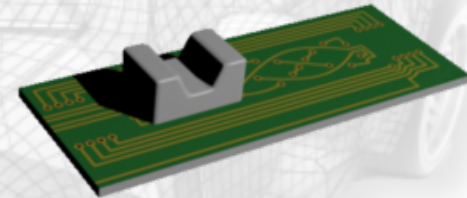
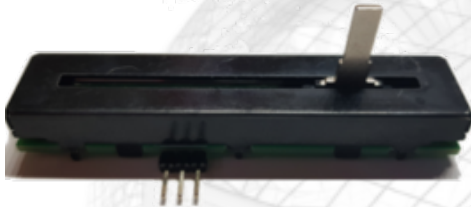
Position
Sensor



液位检测	Level Sensor
换挡器	Gear Shift Lever Position
双离合器	Dual Clutch Transmission
自动变速器	Automatic Manual Transmission
一般应用	General purpose linear potentiometers
其他	Etc..

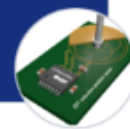
Non-Motor Comm.

Linear



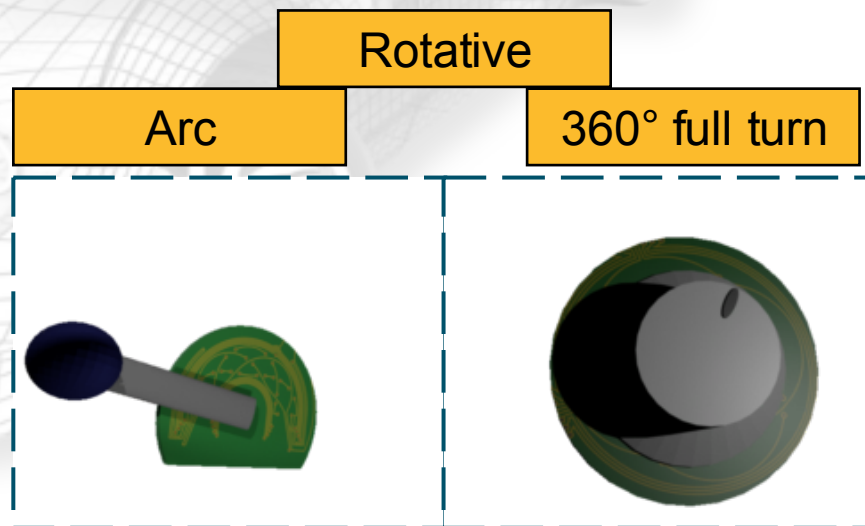
Typical Rotative Applications

Position
Sensor



节气门 Throttle Position Sensors (TPS)
废弃排放 Exhaust Gas Recirculation (EGR)
油门踏板 Accelerator Pedals
雨刷感应 Wipers position sensors
悬架高度 Suspension height (Chassis ride)
旋变编码 Encoders
旋钮 Knobs
机器手臂 Robot joints

Non-Motor Comm.

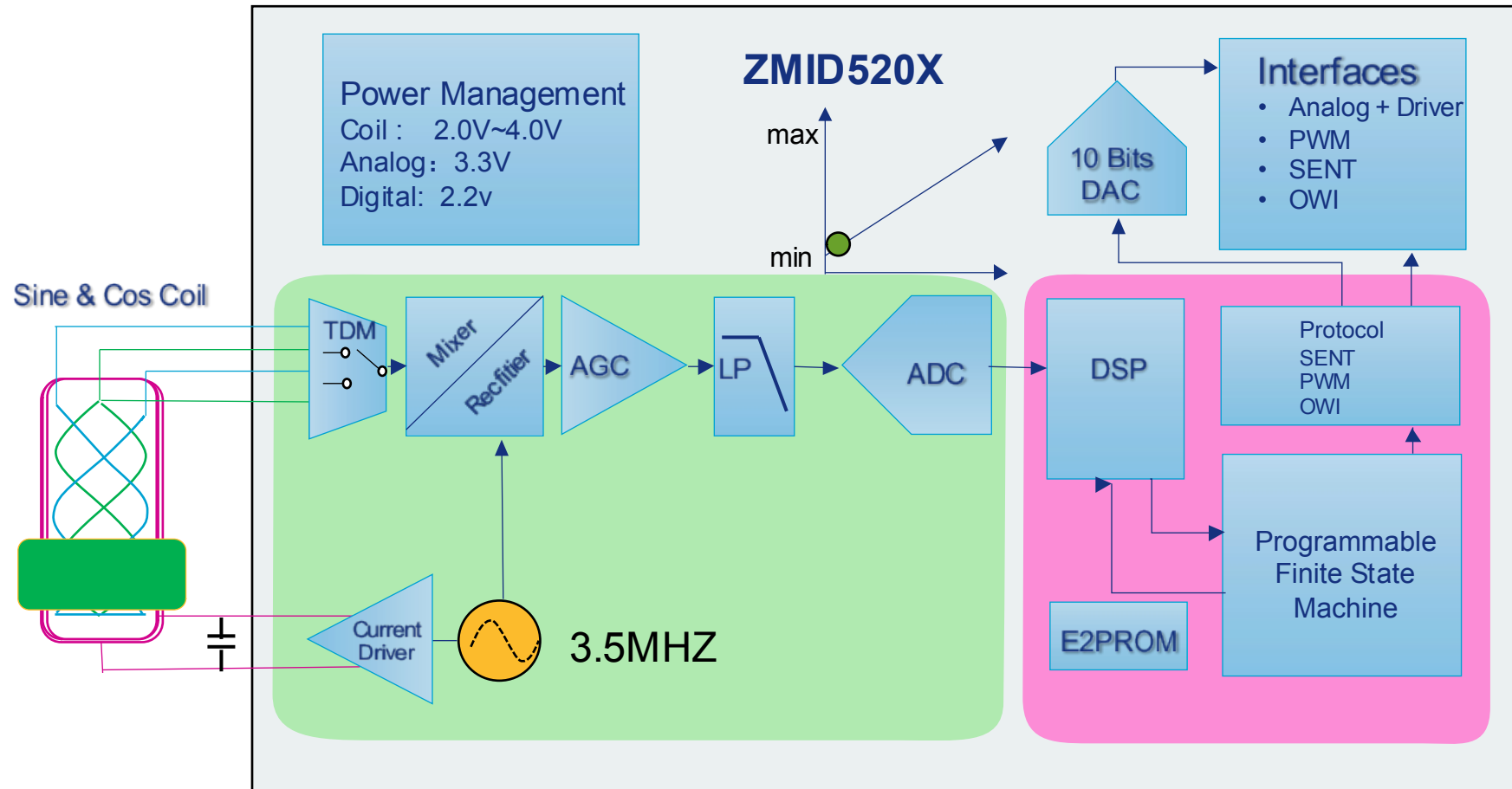
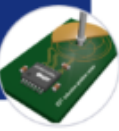


Position Sensors

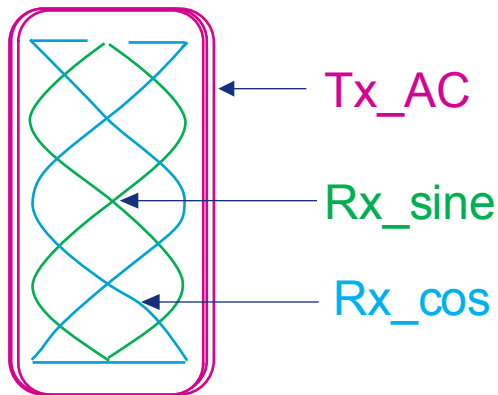
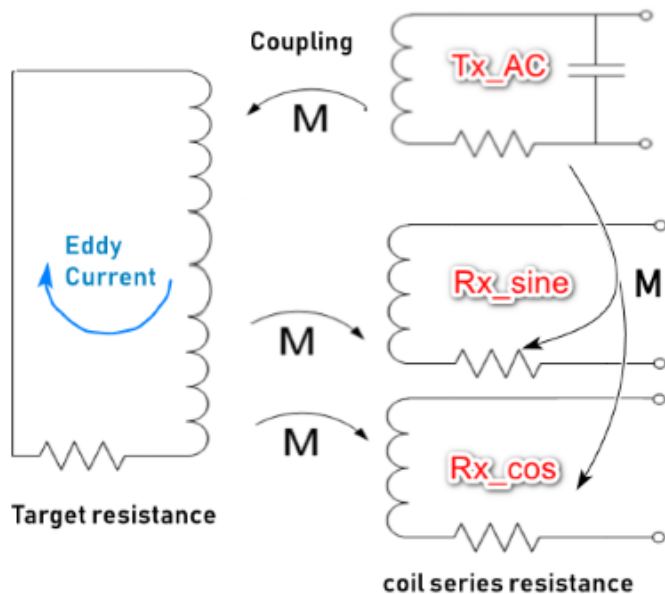


Inductive Position Sensing Technology

Block Diagram

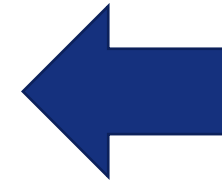


Eddy Current Effect



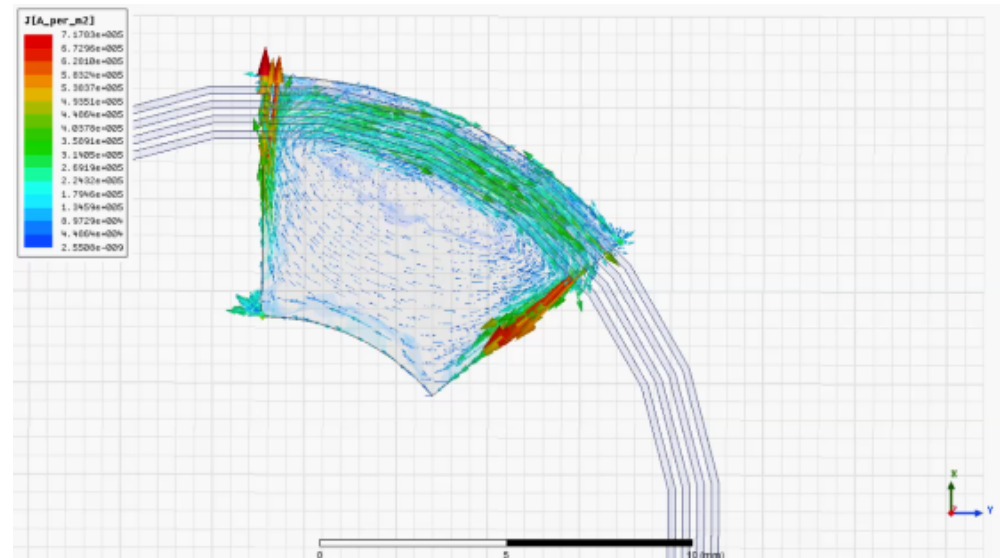
Eddy current property

- Amplitude
- Phase
- Flowing type



Target property

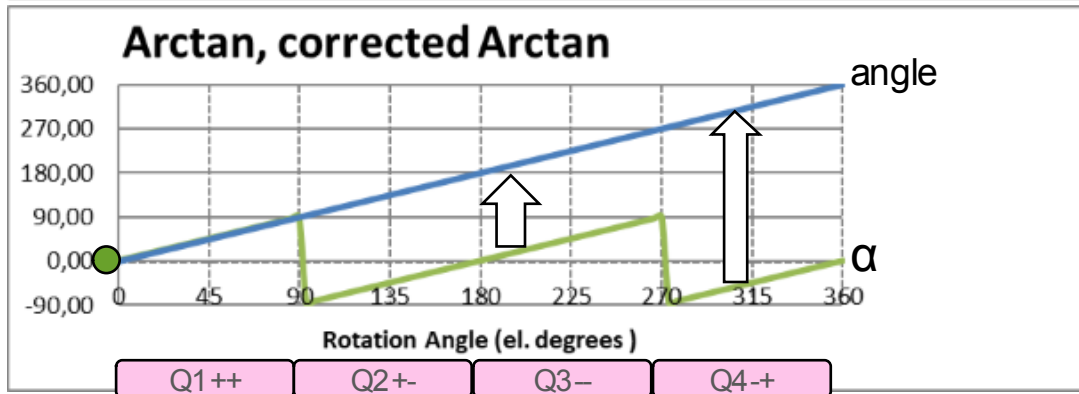
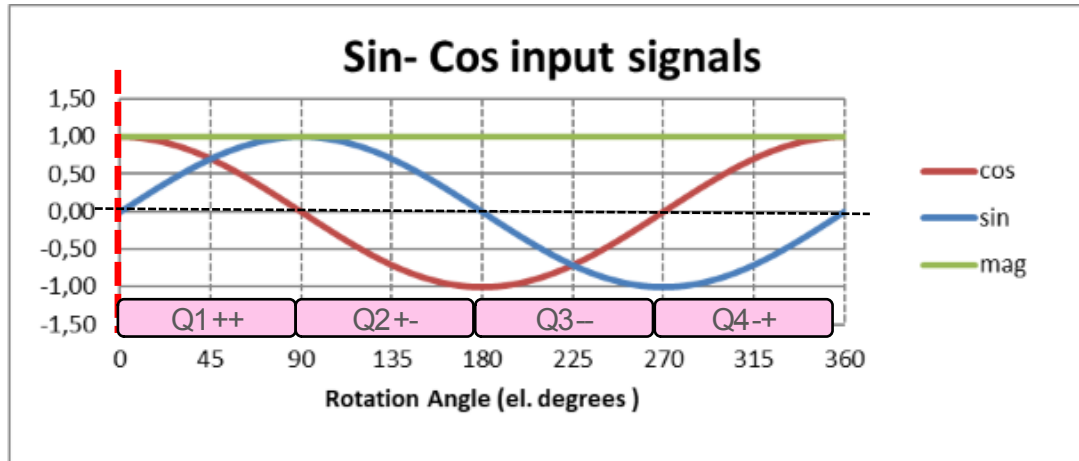
- Magnetic conductivity(μ)
- Electric Conductivity(σ)
- Shape of target
- Size of target



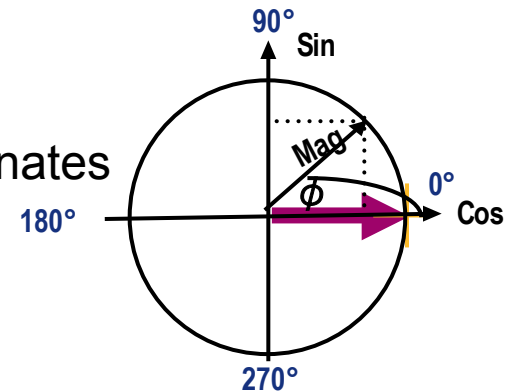
Theory



Rectangular coordinates



Polar coordinates

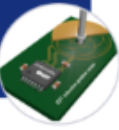


Step	Formula
1	$\frac{\cancel{r} \cdot \sin(\alpha)}{\cancel{r} \cdot \cos(\alpha)} = \tan(\alpha)$
2	$\arctan \frac{\cancel{r} \cdot \sin(\alpha)}{\cancel{r} \cdot \cos(\alpha)} = \arctan(\tan(\alpha)) = \alpha$
3	Q1: angle = α Q2,Q3: angle = $\alpha + 180$ Q4: angle = $\alpha + 360$
4	$magnitude = \sqrt{(V \sin)^2 + (V \cos)^2}$

CORDIC = Coordinate to Rotation Digital Computer: Converts rectangular coordinates (sin,cos) into polar coordinates (angle, magnitude)



Airgap versus Coil Size

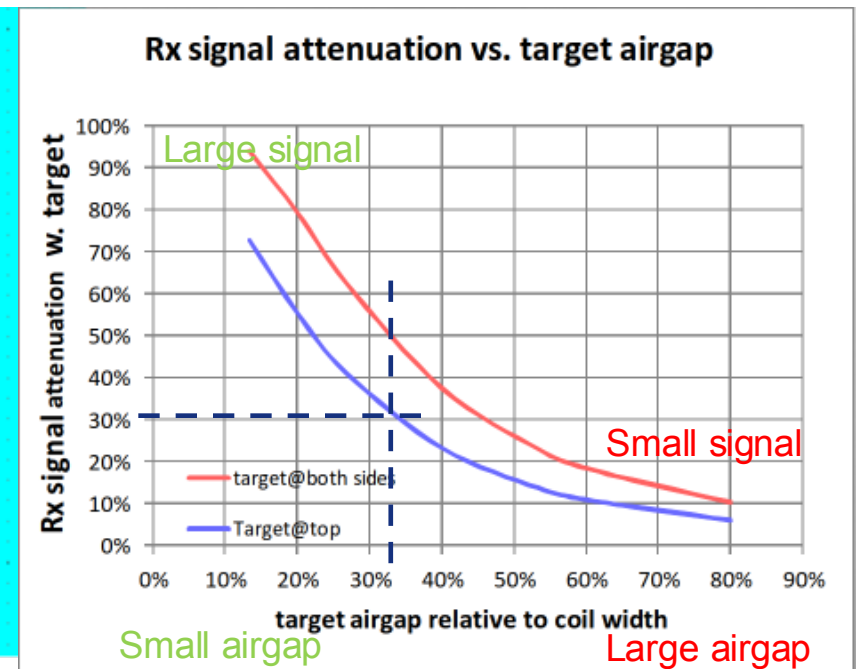
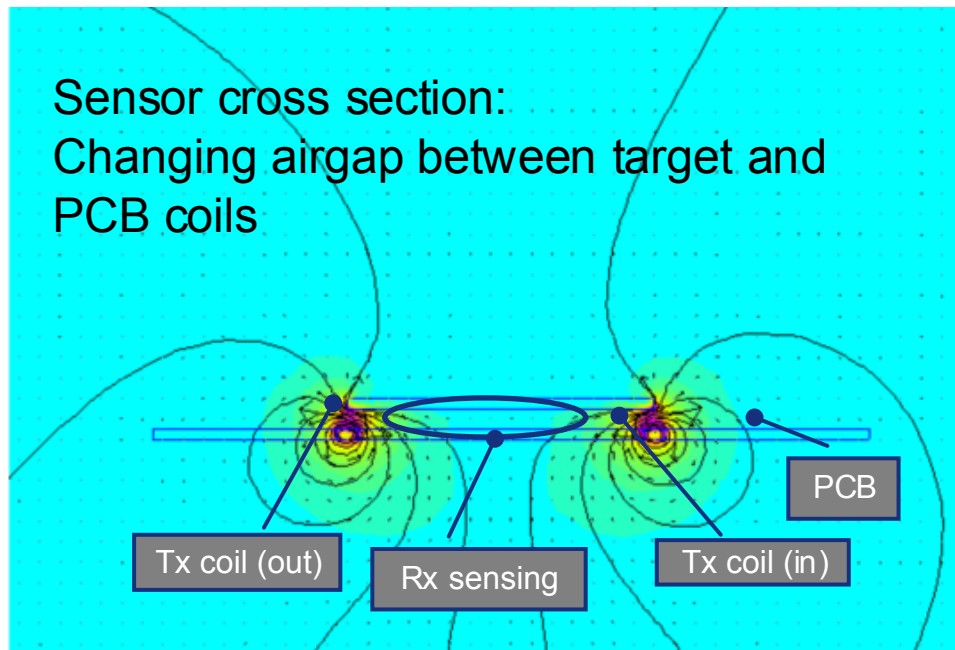


- Short airgaps between target and coils provide good Rx signal (low noise).
- Increasing airgap reduces the signal strength (weaker signal).
- Due to ratiometric measurement, change in airgap does not change the angle value !

Magnetic circuits can be easily scaled: double coil width = double airgap

Max airgap should be ~30-40% of Tx coil width or coil radius

e.g.
<~2 mm airgap for 6mm Tx coil width
<~5 mm airgap for 15mm Tx coil width



What about metallic objects at the bottom of the Sensor ?

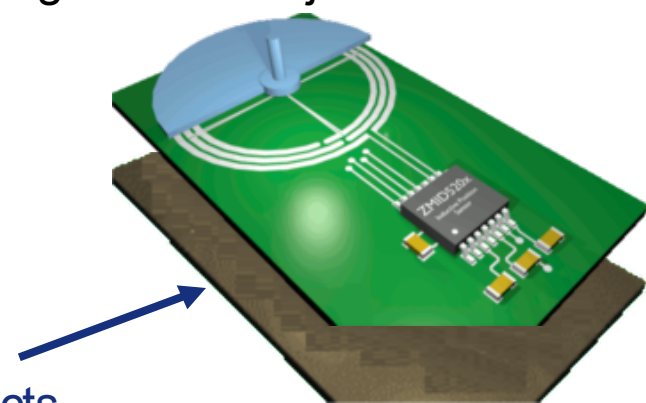


The sensor cannot distinguish a metallic object on the top or at the bottom of the coils !

Metallic objects (e.g. ground planes, metal housings) will weaken the magnetic field, but can still be placed **close to the bottom of the sensor**, as long as they are **not moving** relative to the coils. Possible non-linearities caused by non-moving unwanted metal objects can be corrected by linearization.

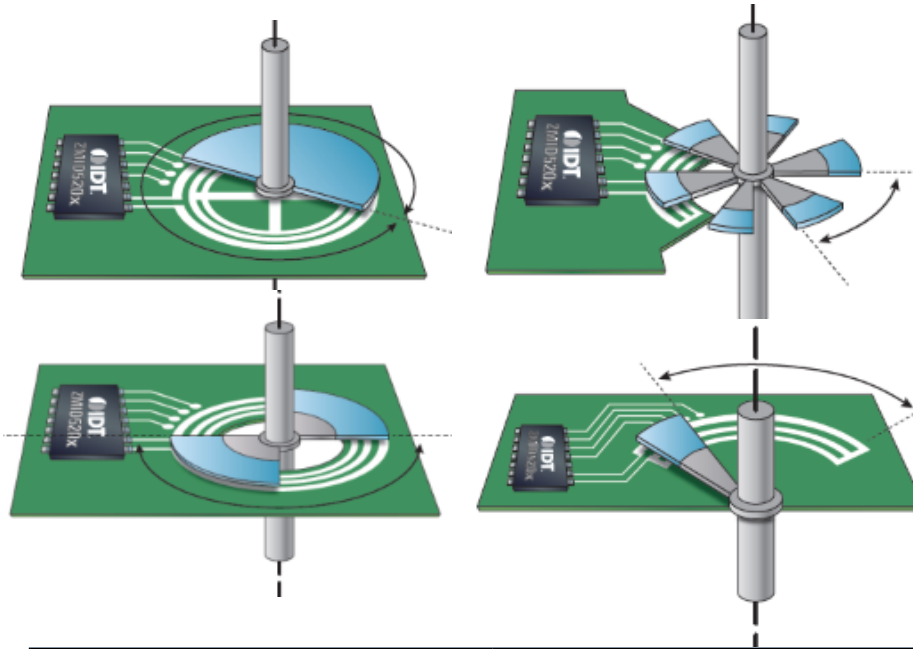
Unwanted **moving** metallic objects at the bottom of the coils are OK if they are placed **far enough away from the coils**.

minimum distance (airgap) of an unwanted moving metallic object =
>2x coil width (linear) or
>2x coil radius (rotary)



Metallic objects

Accuracy changes with angle range



Accuracy = Actual position vs. measured position: down to **0.2% full scale (FS)**
 Imperfections on coil design (e.g. offsets, non-linearities) can be corrected on-chip by offset-correction and 9-point linearization in a non-volatile memory
 Resolution = number or size of steps within the angle range

Angle Range	Resolution in mech° ZMID5201, -5202 (AngleRange/1024)	Resolution in mech° ZMID5203 (AngleRange/4096)	Accuracy @ 0.2% Full Scale in mech° (AngleRange x 0.002%)
20° (e.g. Pedal)	0,02°	0,005°	0,04 °
90° (e.g. Throttle)	0,09°	0,022°	0,18 °
180° (e.g. Robot)	0,18°	0,044°	0,36 °
270° (e.g. Potentiometer)	0,26°	0,066°	0,54 °
360° (e.g. rotary knob)	0,35°	0,088°	0,72 °



ZMID520x

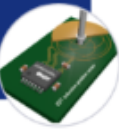
Inductive Position Sensors



Stray Field Immunity

Why Stray Field immunity ?

Position
Sensor

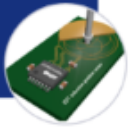


1. Higher electrification in cars (Hybrids, Electric vehicles, added comfort)
2. Increasing number of sensors in cars
 - Up to 50 position sensors in a vehicle
3. **Strong currents in electric wires generate (unwanted) magnetic stray fields**
 - Battery charger
 - Electric drive motors
 - Electric braking
 - Electric suspension
 - Future wireless charging stations create large magnetic stray fields

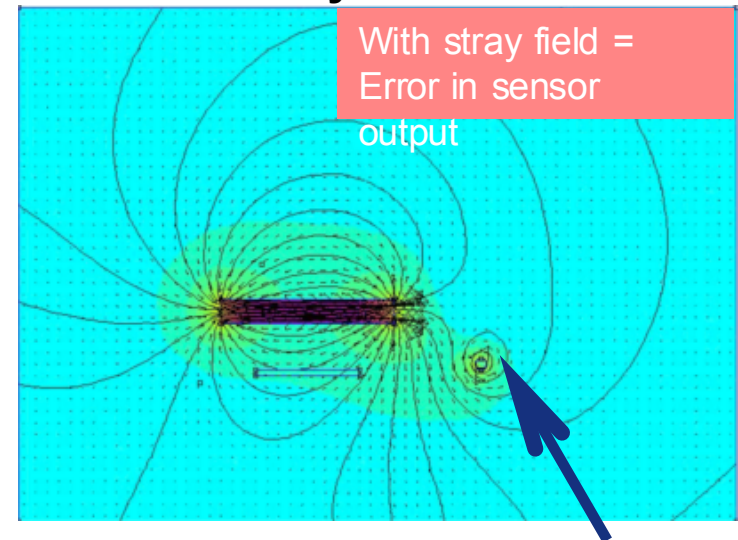
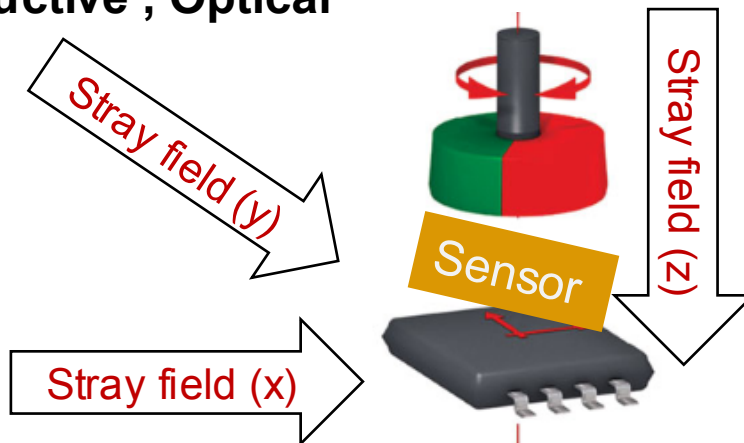


**Magnetic stray fields
are disturbing
magnetic sensors**

Stray Field immunity is defined by regulation bodies



- Due to increasing electrification in vehicles, the limits for stray field immunity have been risen **by a factor of 3 and more** by OEM's and regulation bodies
- ISO11452-8:
 - was: Stray field ≤ 1000 A/m (until June 2015)
 - new: Stray field ≤ 3000 A/m (since June 2015)
- Some OEM's demanding up to 4000 A/m
- **This change benefits sensors that are immune to stray fields -> Inductive , Optical**

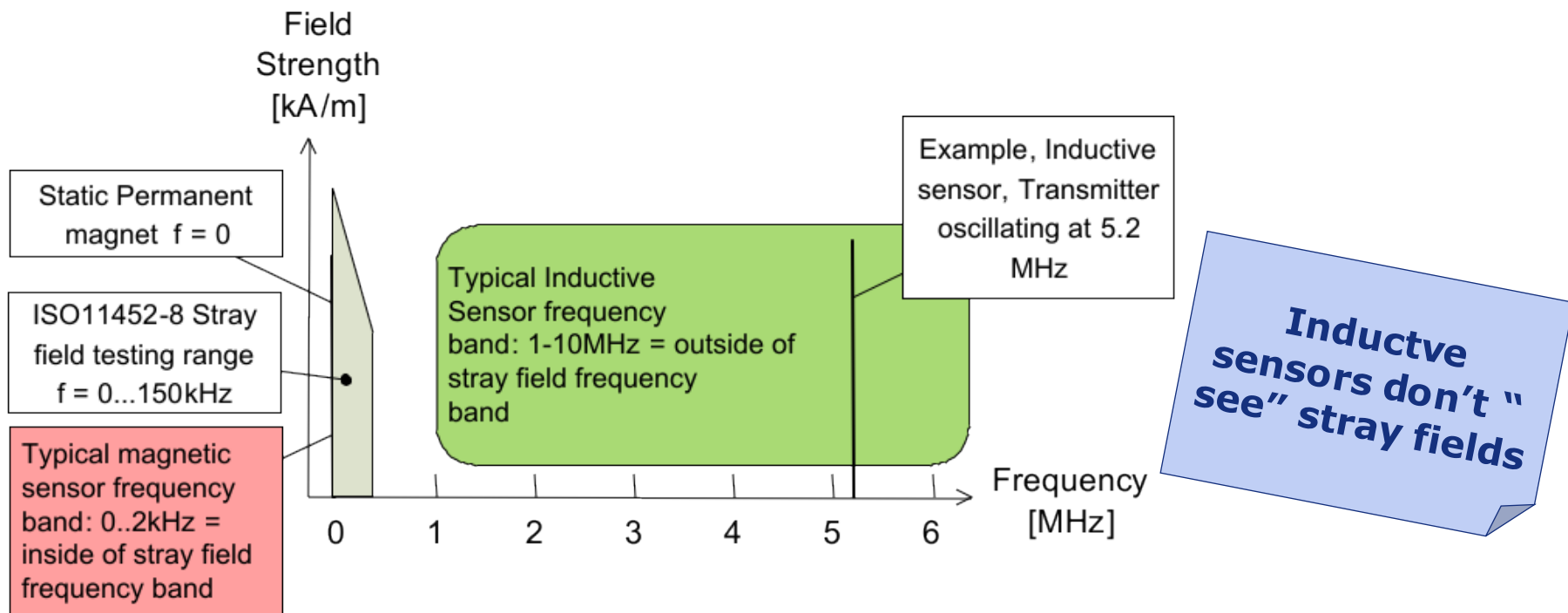


Current in a cable generating a stray field

Why are Inductive Sensors not affected ?



- Magnetic stray fields are generated in the range of 0...150 kHz
- Magnetic sensors (Hall, AMR, GMR, TMR) operate in the range of 0...~2 kHz . This is **inside** the stray field frequency band
- Inductive sensors don't use permanent magnets. They operate in the range of 1-10 MHz. This is **outside** of the stray field frequency band



ZMID520x

Inductive Position Sensors

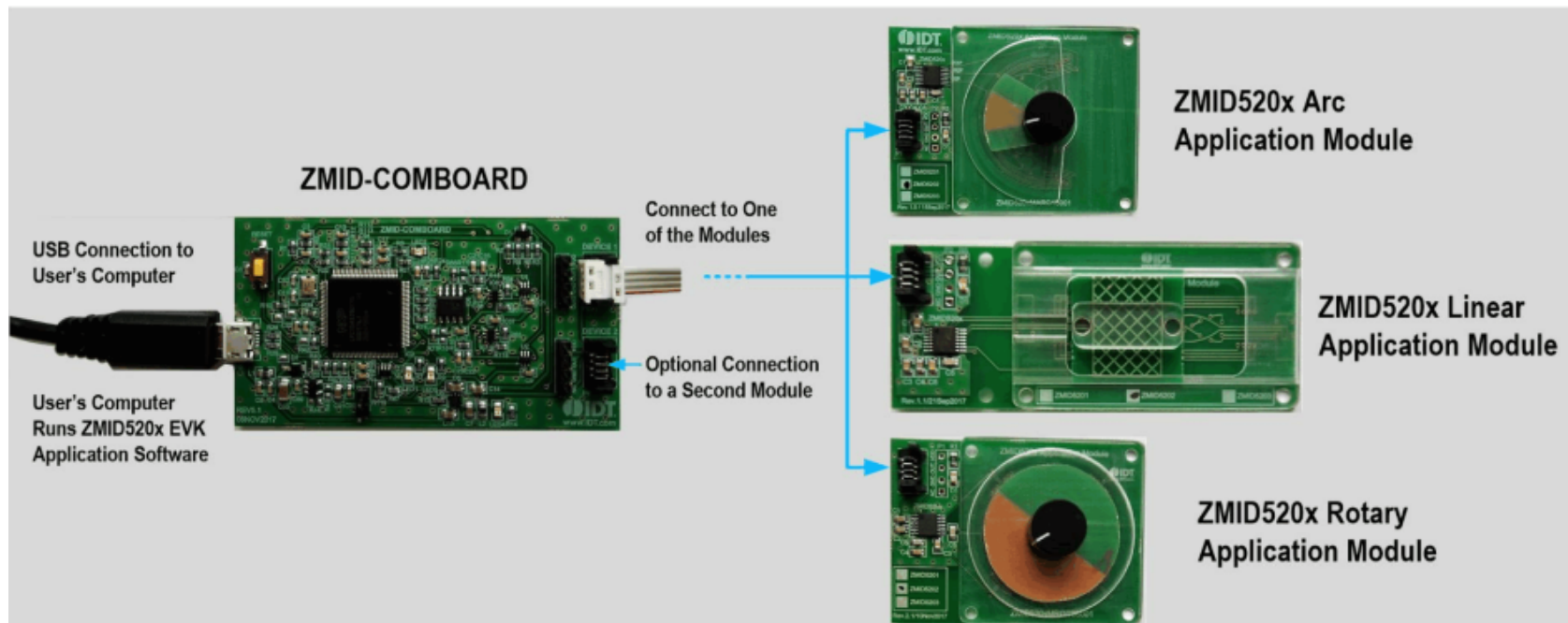


EVK Introduction

EVK Introduction



<https://www.idt.com/products/sensor-products/position-sensors/zmid5201stkit-zmid5201-inductive-position-sensing-starter-kit>



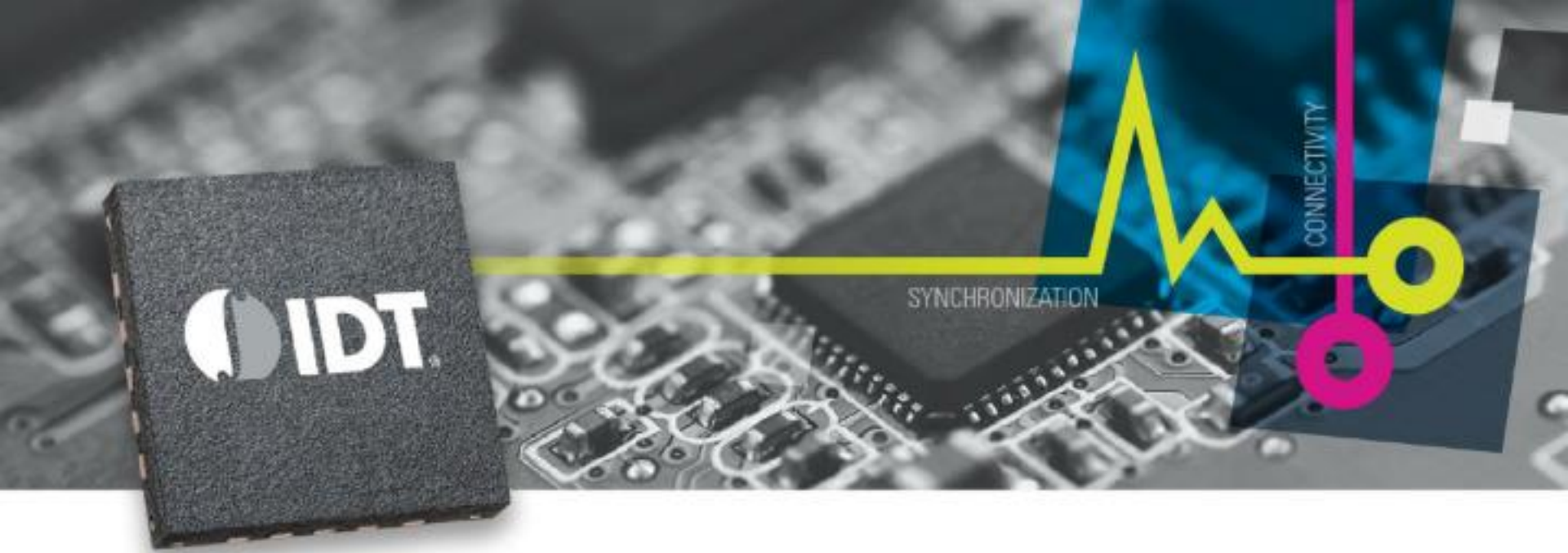
Includes:

- **Configuration:** EEPROM/data write/read
- **Calibration:** Offset, Slope, linearization
- **Performance evaluation:** operation, magnitude, angle



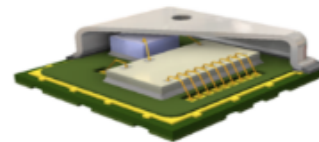
Thank You

Analog Mixed Signal Product
Leadership in Growth Markets



Introduction to IDT Gas Sensor

Oct 2018



VOC: Volatile Organic Compounds



BUILDING MATERIALS

- carpets & adhesives
- sealing caulk
- paint
- composite wood products
- upholstery fabrics
- solvents
- varnishes
- vinyl flooring



HOME & PERSONAL PRODUCTS

- air fresheners
- fuel oil & gasoline
- cosmetics
- ozone-producing products
- cleaning products
- moth balls
- vehicle exhaust



FUELS & MACHINERY

- cooking
- dry cleaning
- photocopiers
- space heaters
- dry cleaning
- tobacco smoke
- wood-burning stoves
- stored paint & chemicals

Indoor Air Quality



•Foul
Odors

Bathroom
Fans

•Cooking
Odors

Kitchen
Fans



•IAQ /
TVOC
•eCO₂

HVAC
Systems

•Odors
•eCO₂

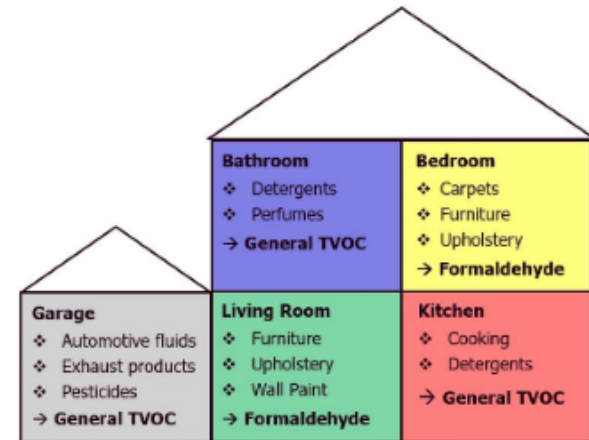
Bedroom



Importance of Indoor Air Quality

Health effects from elevated exposure to VOC

- Eye, nose and throat irritation
- Headaches, loss of coordination and nausea
- Damage to liver, kidney and central nervous system
- Some organics can cause cancer in animals, some are suspected or known to cause cancer in humans



Sources of Common Indoor VOC

VOC Class	Examples	Source
Alkanes	n-Butane, n-Octane	Aerosol spray products, cosmetics
Alkenes	Isobutylene, Ethylene	Solvents, fruit ripening, pest control, rubber
Aromatics	BTEX, Naphthalene, Styrene	Tobacco smoke, moth balls, air fresheners, automotive exhaust products
Halocarbons	Methylene chloride, PERC, R125, R-410A	Dry cleaned clothes, refrigerant, dehumidifiers, urinal deodorizer block
Alcohols	Ethyl Alcohol, Isopropyl Alcohol	Cleaning agent, plasticizer, hair spray
Terpene	α -Pinene (pine odor), d-Limonene (citrus odor)	Cosmetics, citrus/orange oil, pine oil cleaners, fragrance additive, wood
Aldehyde	Formaldehyde, n-Hexanal	Disinfectants, upholstered furniture, carpets, plywood
Ketones	Acetone, Methyl Ethyl Ketone (MEK)	Nail polish remover, PVC cement and primer, various adhesives
Siloxane	Octamethylcyclotetrasiloxane (D4)	Cosmetics, soaps, defoamer, detergent, antiperspirants

Indoor Air Quality (IAQ) Rating

IDT IAQ Rating	Reference Level*	Air Information	TVOC (mg/m ³)	Air Quality
≤ 1.99	Level 1	Clean Hygienic Air (Target value)	< 0.3	Very Good
2.00 – 2.99	Level 2	Good Air Quality (if no threshold value is exceeded)	0.3 – 1.0	Good
3.00 – 3.99	Level 3	Noticeable Comfort Concerns (Not recommended for exposure > 12 months)	1.0 – 3.0	Medium
4.00 – 4.99	Level 4	Significant Comfort Issues (Not recommended for exposure > 1 month)	3.0 – 10.0	Poor
≥ 5.00	Level 5	Unacceptable Conditions (Not recommended)	> 10.0	Bad

Basis for Determination

- Study by German Environmental Agency (UBA)
- Evaluated at IDT's gas labs

Certification for ZMOD

- External 3rd party laboratory study with independent evaluation of conformance

* Source: Umweltbundesamt, *Beurteilung von Innenraumluftkontaminationen mittels Referenz- und Richtwerten*, (Bundesgesundheitsblatt - Gesundheitsforschung - Gesundheitsschutz, 2007).

Key Attributes of IDT Gas Sensors vs. Other Gas Detection Solutions

Competing Technologies

Electrochemical

+ VOC

- Less Robust
- Shorter lifetime
- Expensive

PID

+ VOC, methane
+ Low Detection limits

- Higher maintenance
- Shorter lifetime
- Expensive

NDIR

+ VOC, CO₂

- Not for trace detection
- Expensive

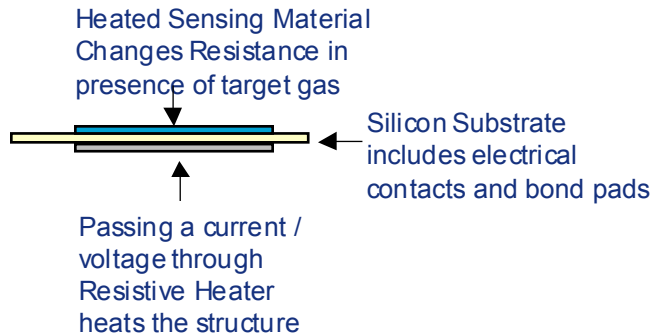
IDT Technology

Chemiresistor

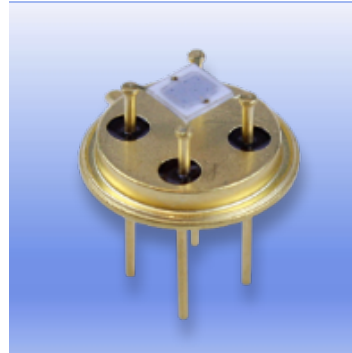
++ VOC, e-CO₂
++ Low Detection limits
++ Long Lifetime
++ No Maintenance
++ Low Price



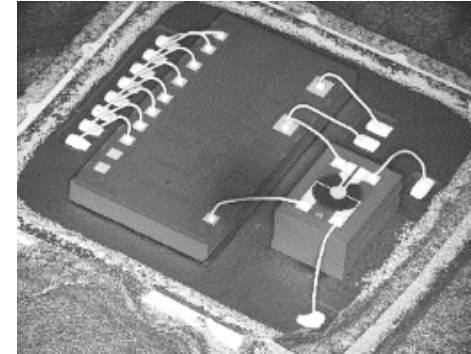
IDT's MOx Gas Sensor Technology



Working Principle



Ceramic-based
Analog Gas Sensor

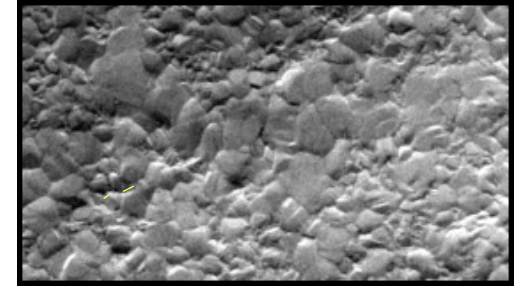


Silicon-based
Digital Gas Sensor

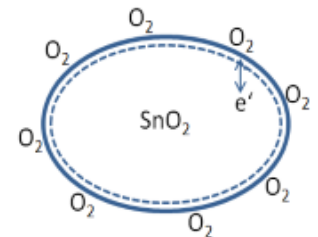
- Sensors reliably measure gases in air
- Fast response and recovery to gas
- Excellent stability and sensitivity
- Sensors operate via diffusion or active flow

Metal Oxide (MOx) Sensor Principles

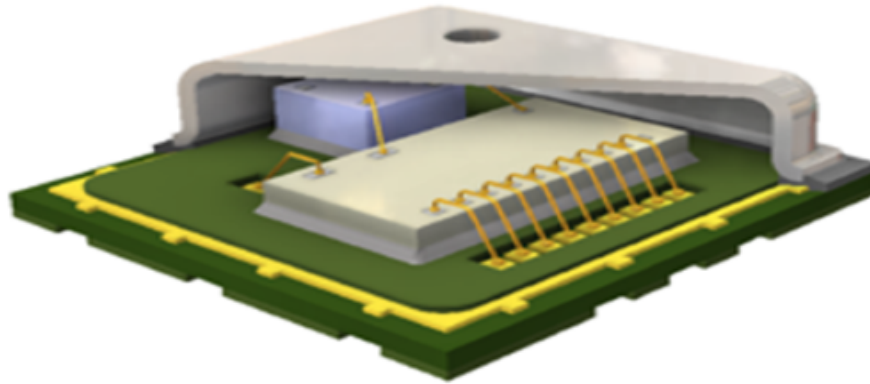
- Working Principle of Chemiresistor
 - Gas generates free charge carriers in MOx
 - Changes resistance of MOx
- Influences to MOx Resistivity
 - Temperature
 - Gases (present atmosphere)
 - Oxygen Concentration
 - Surface geometry (particle shape & production technology)
- Chemisorption reaction on surface of MOx
 - Oxygen is adsorbed at different phases on MOx surface
 - Gas molecules arrive and adsorb on sensor surface
 - Reaction between gas and oxygen
 - Oxygen equilibrium on surface is disturbed, transferring charge



Fired Material at 800°C

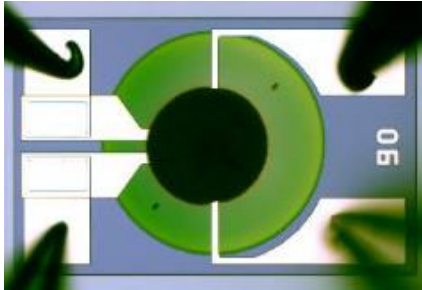


ZMOD Platform

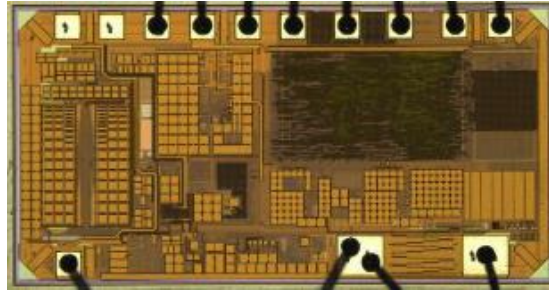


3.00 x 3.00 x 0.70 mm LGA

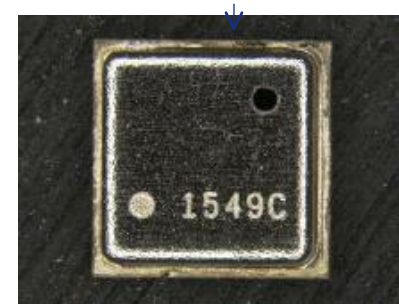
ZMOD4xxx Combines Proven Elements in a System



Si-based Micro hotplate
with Metal Oxide coating

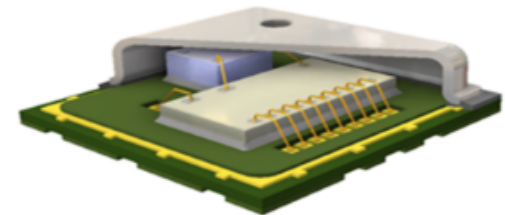


ZSSC3250 ASIC
for I²C output



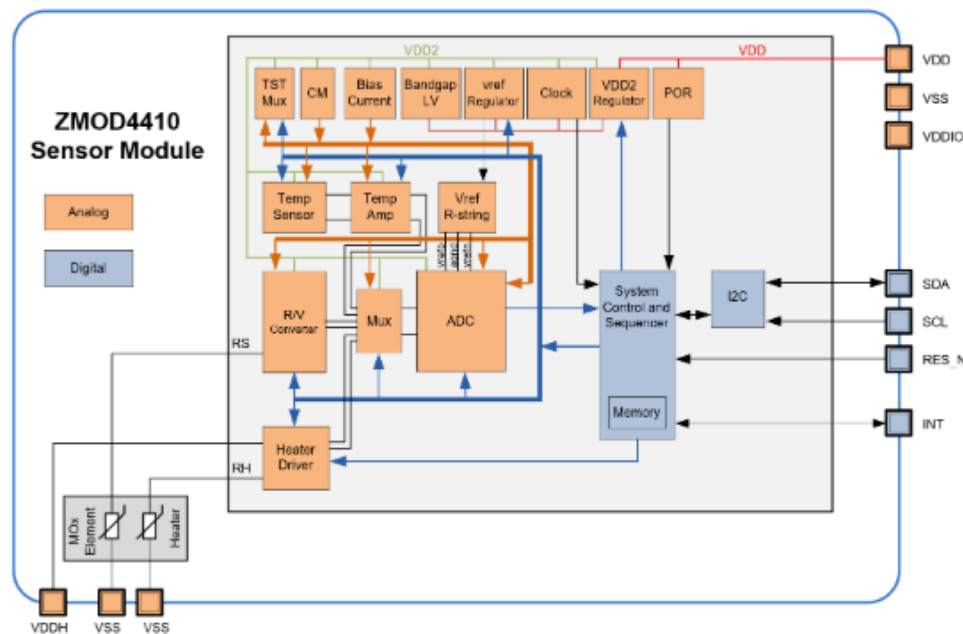
Package with Gas Inlet

- ✓ Upgradeable platform leveraging multi sequence flexibility
- ✓ MOx material with 12 years of experience, proven stability
- ✓ Calibrated solution with easy I²C integration

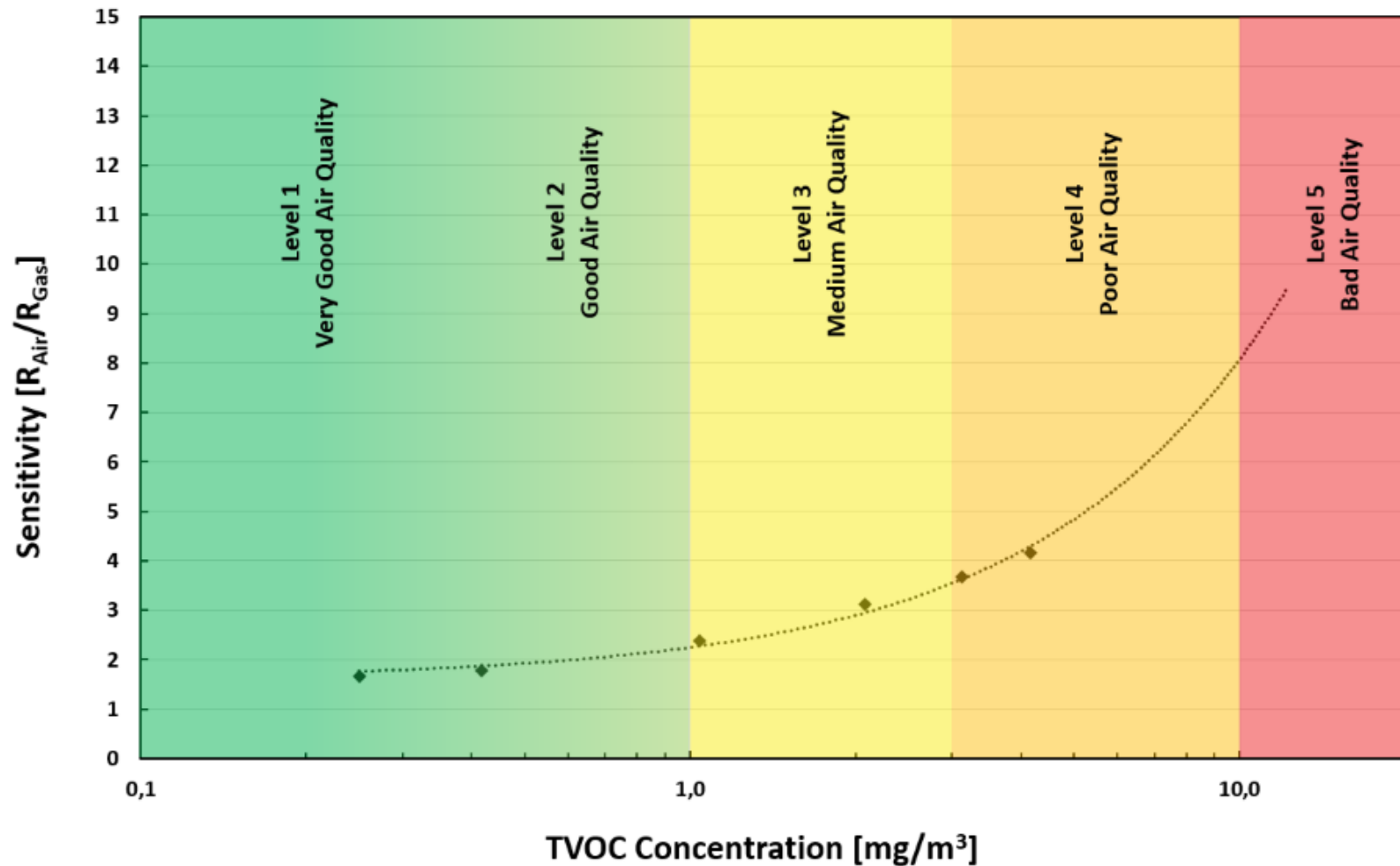


ASIC Flexibility and Sensor Performance

- Accurate heater temperature control ($\pm 0.5\text{K}$)
- Digital communication with I²C interface with up to 400kHz
- ADC resolution: adjustable for speed and resolution (max.16-bit)
- Tailored temperatures enable sensitivity to target gases and selectivity
- New products and features via software upgrade to ASIC settings

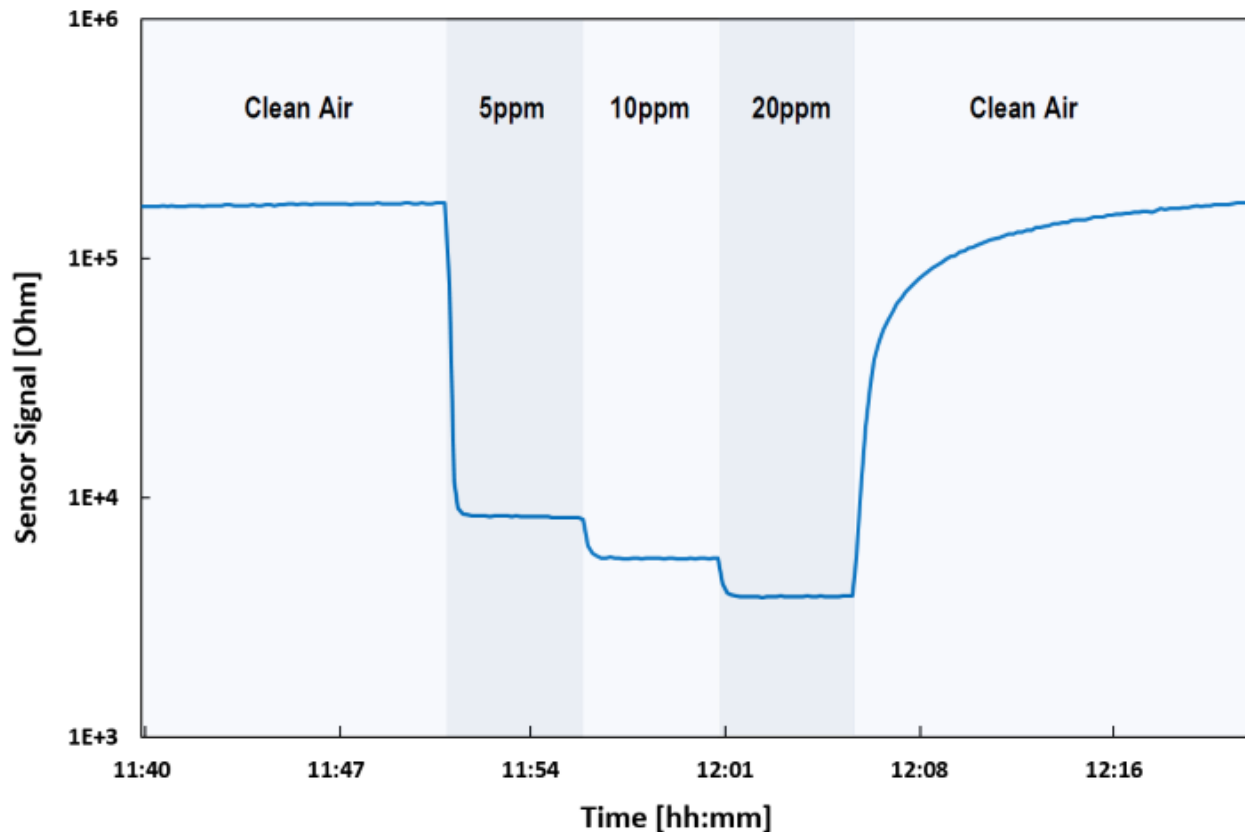


ZMOD4410 Response to UBA Study



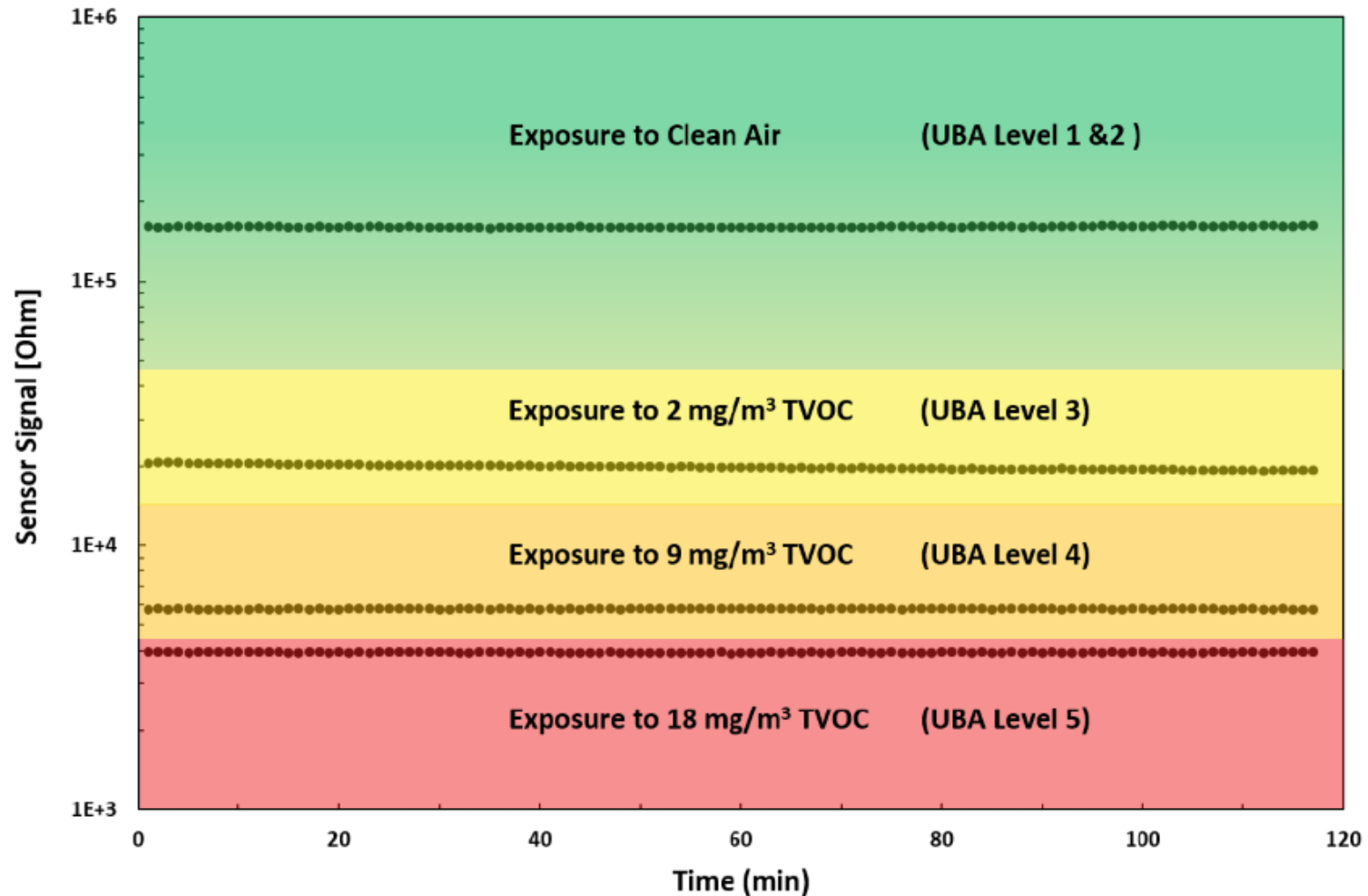
TVOC is a subset 25 of EPA's TO-15/17 certified mixtures

Sensor Response Time (TVOC)



- Average Response Time to 90% Full Scale: **7 seconds**
- Influenced by
 - Test Chamber and Tubing (dead volume)
 - Gas Flow Rate
 - Sensor Sampling Rate

Stability and Accuracy of a Calibrated Sensor Response



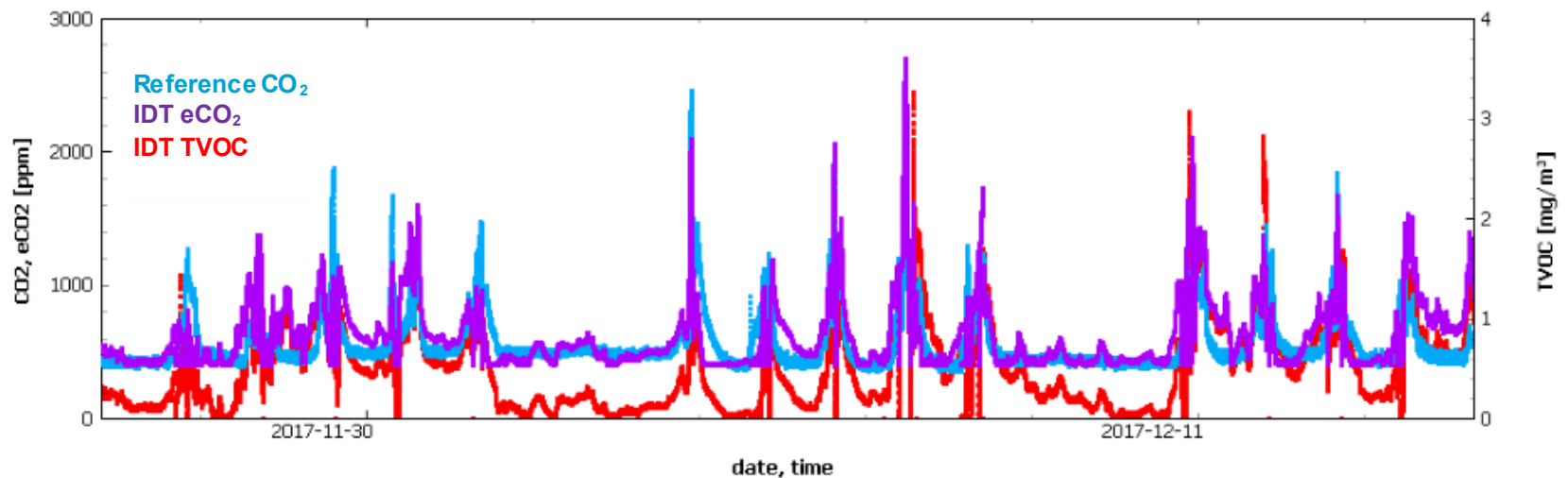
eCO₂ Correlation

- IDT has collected months of continuous measurement data from several locations in offices, labs, homes, kitchens in different countries
- Referenced to different high-end CO₂ instruments
- Results were used for an estimated CO₂ algorithm (“eCO₂”)
- Algorithm is secured with a patent (pending)

→ One sensor provides 2 readings

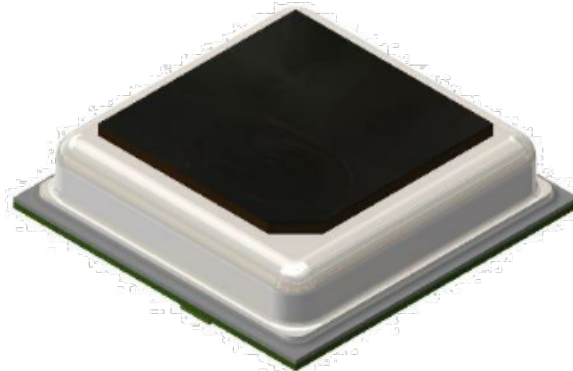
→ TVOC

→ eCO₂ - Human source



Waterproof

- IDT's gas sensor has been tested with different membranes.
- Membranes tested are both hydrophobic and oleophobic, and are permeable to humidity and VOC at the same time.
- All tests have been performed at different gas concentrations and were repeated.
- A suitable membrane material has been identified which is suitable for permeation of target gases (pending patent).
- IDT can provide waterproofed sensors or support design of the sensor into a waterproofed device (IP68 classification)



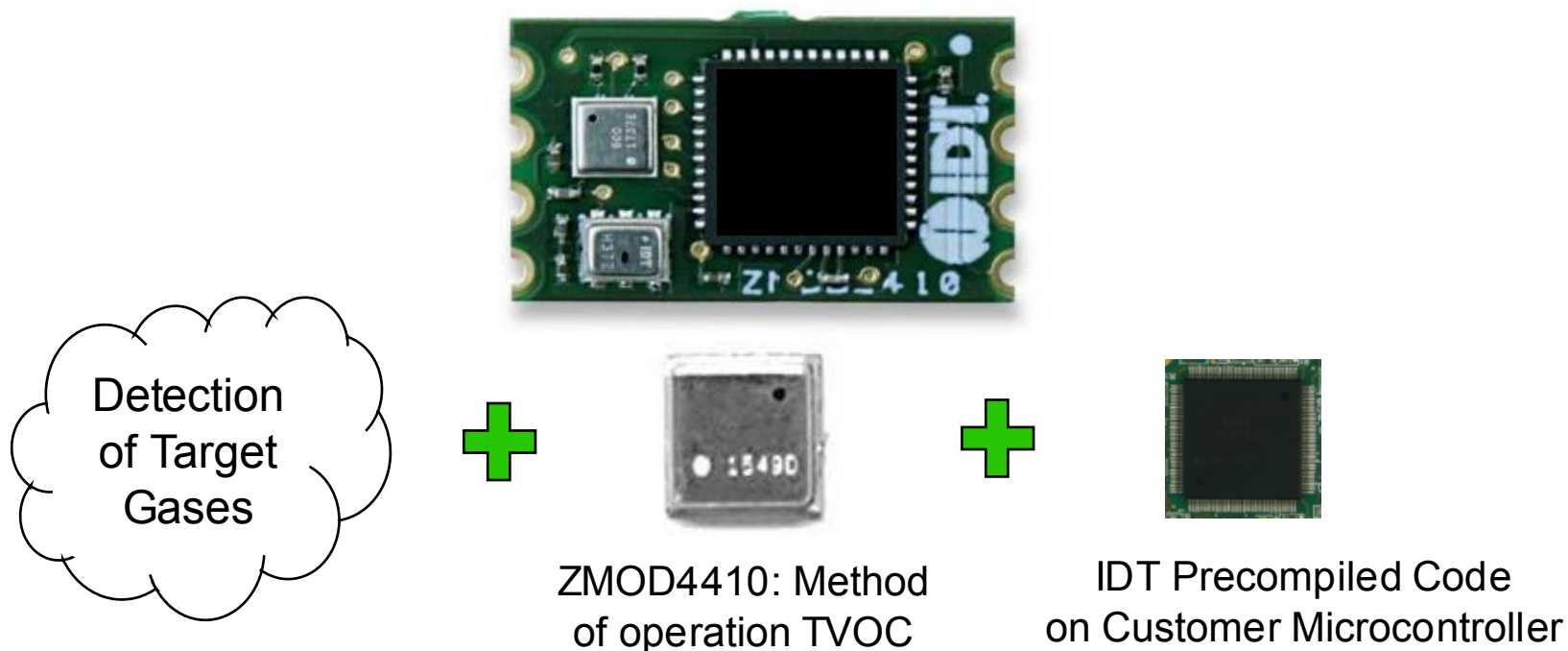
Key Attributes of IDT ZMOD Sensors vs. Other Solutions

IDT MOx Technology

- **Best-in-class reliability**, expressed by signal to noise
 - Signal is sensitivity to the target gas, e.g. VOC
 - Noise is everything else, e.g. drift, response to humidity...
- **Over 10 years of experience** supplying sensors into regulatory environments; performance is proven in demanding applications
- **Best-in-class technical support**: detailed collateral, dedicated application engineering team at three engineering gas lab locations

	ZMOD4410	Other MOx Sensors	Electrochemical	PID
Reliability	Excellent	Good	Easily Damaged	High Maintenance
Lifetime	Long (5+ years)	Long	2 years typical	3 years typical
Range	Best < 0.1 ppm to 1000 ppm	Very Good	Good at higher end	Good at low end

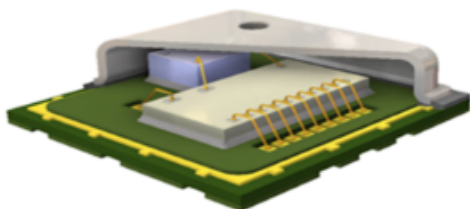
Typical System Integration



Application	µC Platforms* Supported	Application	Microcontroller
ZMOD4410-Standard TVOC / IAQ / e-CO2	ARM Linux MSP430 Windows	Bathroom & Kitchen Fans	ARM Linux MSP430 Windows

*additional Microcontroller platforms to be added

Firmware Upgradeable – Indoor Air Quality

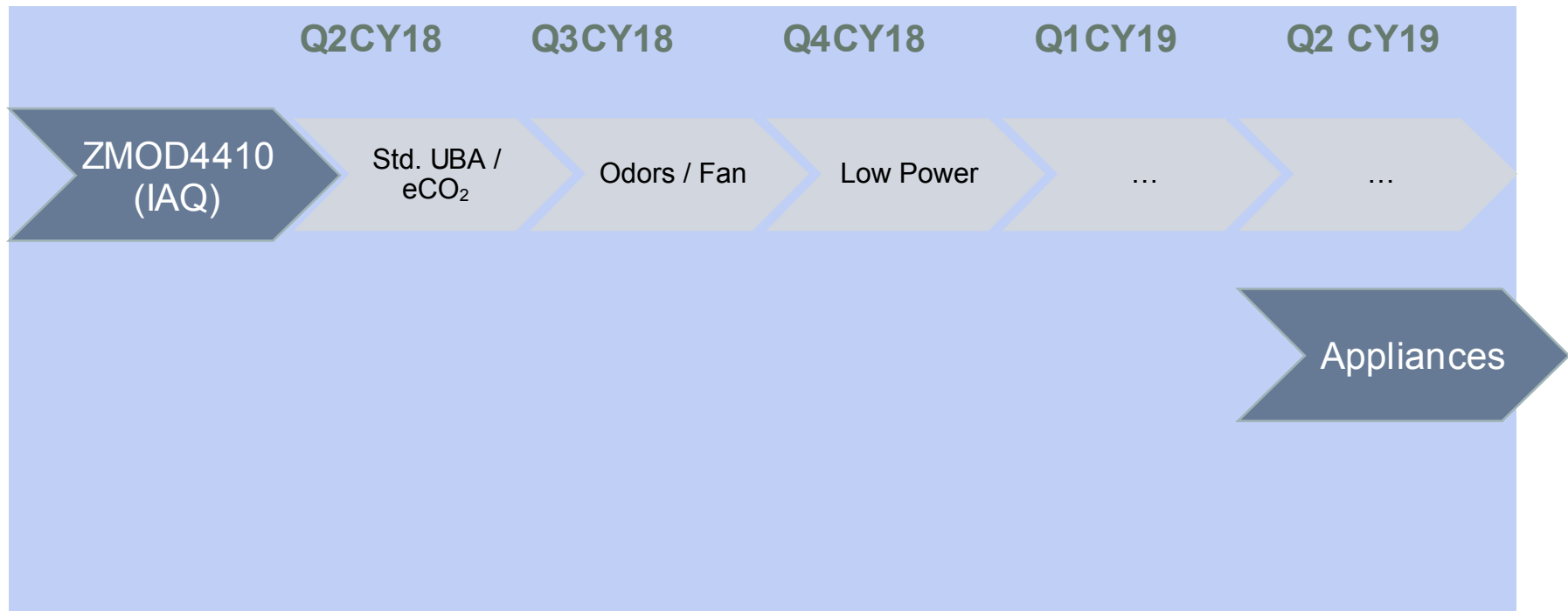


Description	Where Used	Target Gases & Concentration	Sampling Rate	Function	When (CY)
Standard TVOC/IAQ/eCO ₂	HVAC, air conditioners, air purifiers, thermostat, IAQ monitors	TVOC target 160 - 30,000 ppb UBA Level 1 - 5+ eCO ₂ 400 - 5000 ppm	Continuous	Display levels, user alerts, control ventilation	Released
Odors	Bathroom & kitchen fans	VOC (Cleaning agents, toluene, etc.); VSC (volatile sulfur compounds) ppb to ppm	Continuous	Automate ventilation	Released
Low Power (1mW)	IAQ monitors, rechargeable & portable devices	TVOC / UBA / eCO ₂ (see levels above)	6 sec	Display levels User alerts	Release: December 2018

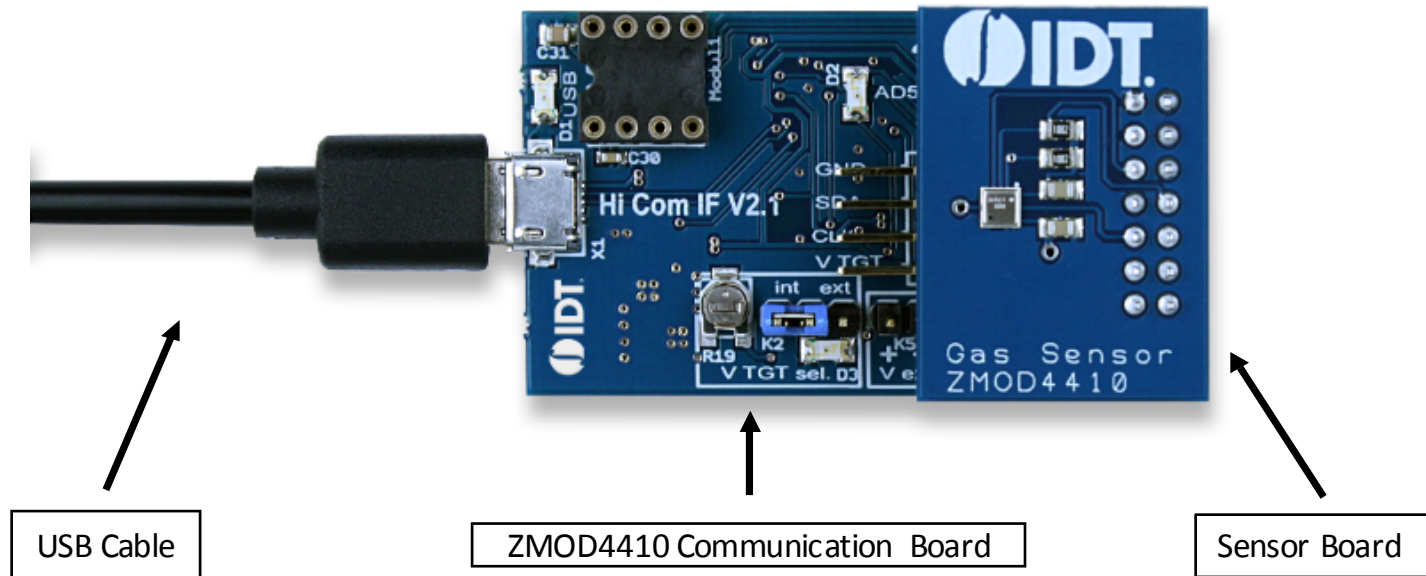
ZMOD4xxx Family Expansion

Near Term Roadmap

Product family defined by MOx, test & calibration
Product releases and features defined by software



HiCom Evaluation Board



A

- 1) Download and install ZMOD4410 demo software from IDT.com/ZMOD4410-EVK.
- 2) You may need to install the FTDI driver at <http://www.ftdichip.com/FTDrivers.htm>.

B

- 1) Attach sensor board to Hi Com board and connect it to the computer with the USB cable.
- 2) Launch ZMOD4410 demo software with the executable file `ZMOD4410_Evaluation_Software.bat`.

We support our Customer with Gas Testing

Solvent Evaporation

- Dispense a known quantity of solvent into a defined chamber
- Equipment required
 - Chamber
 - Microsyringe
 - “Solvent Calculation” spreadsheet
Available upon request to convert volume solvent to concentration (ppm)

Portable Calibration Cylinders

- Low pressure transportable calibration cylinders

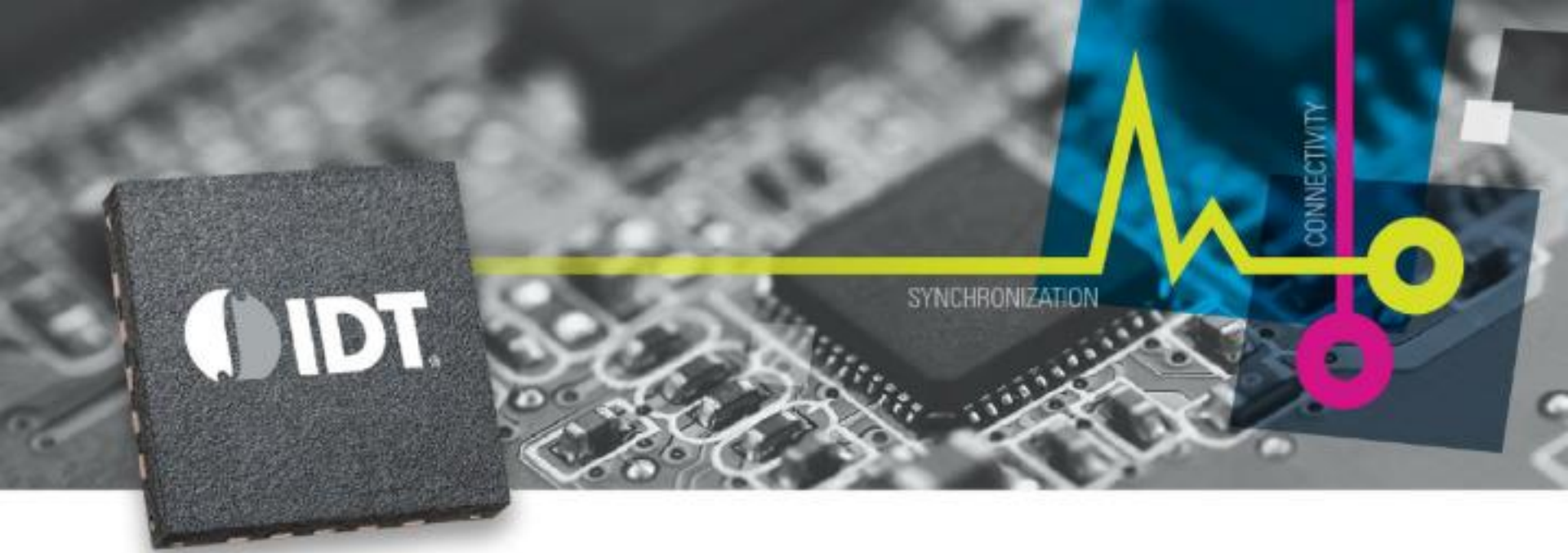
Certified Gas Cylinders and Mass Flow Controllers (MFC)

- Cylinders purchased from Vendor
- MFC used to blend variety of concentrations with high accuracy
- Available at IDT labs in Dresden and Longmont, plus San Jose test floor
- Requires significant infrastructure for safe handling



IDT Advantage

- MOx material
 - 12 years of proven reliability; sensors still in operation recording data
 - Immune from environmental Siloxane contamination
 - ***Best performance in stability and sensitivity***
- ASIC
 - Configurable with steps define a methods of operation
 - ***Rapid new and upgradeable sensors without changing hardware***
- Calibration
 - Electrical and Chemical calibration
 - Each sensor is calibrated with a defined concentration of ethanol
 - ***Consistent performance from lot to lot***
- Clear definition of clean air
 - Collaboration with the German Environmental Agency's (UBA) clean air study
 - 3rd party validation
 - ***End consumers are assured of clean air definition and testing***



Thank You

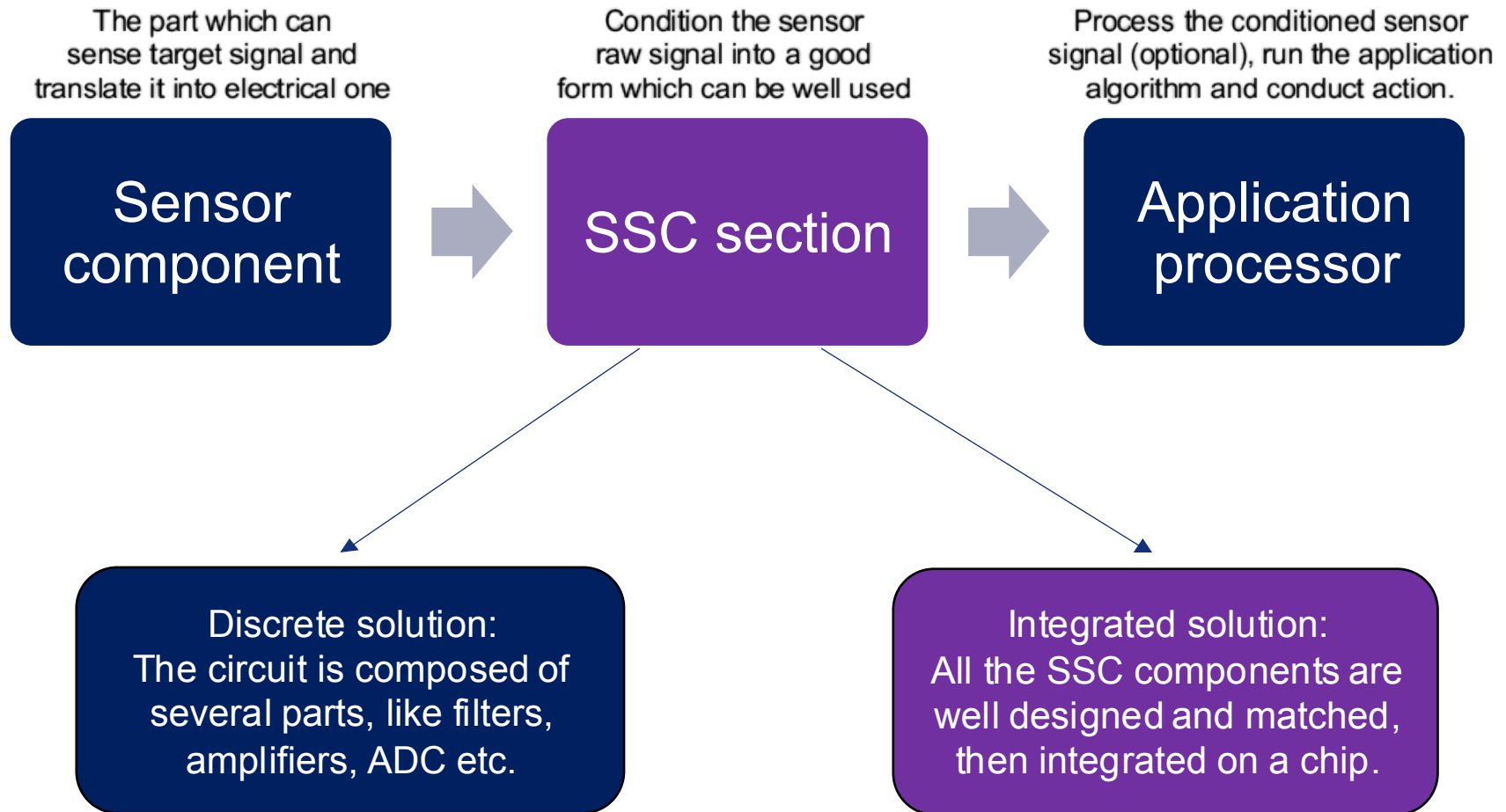
Analog Mixed Signal Product
Leadership in Growth Markets



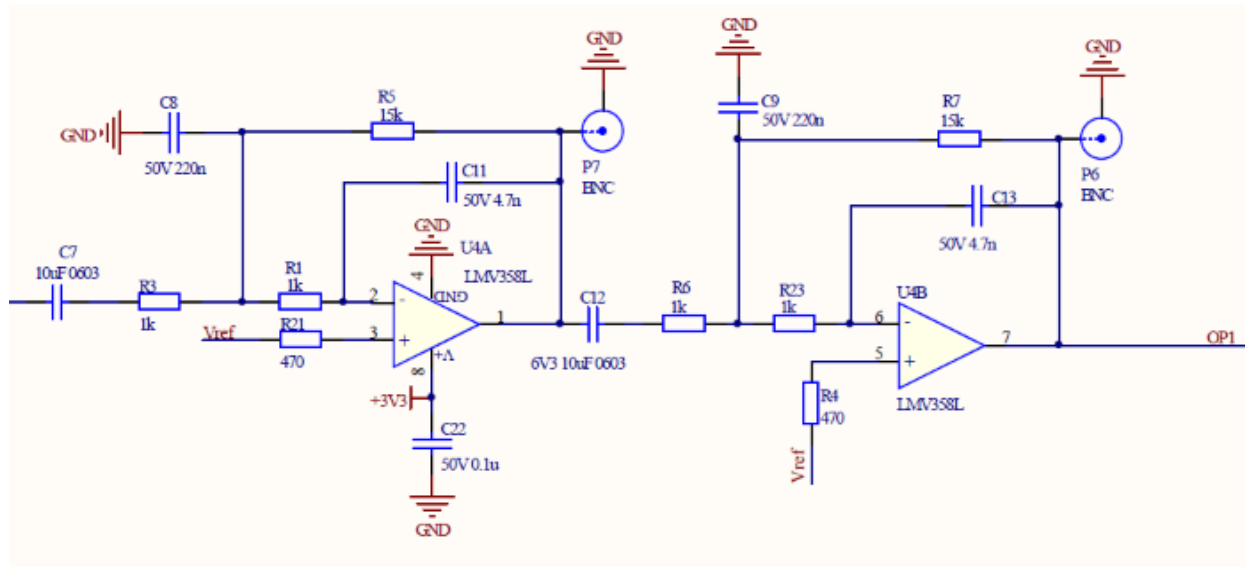
Introduction to IDT SSC design

October 2018

Typical SSC Module Design Solutions

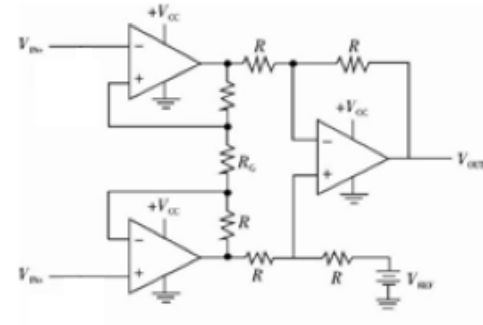


An Example of Discrete Solution

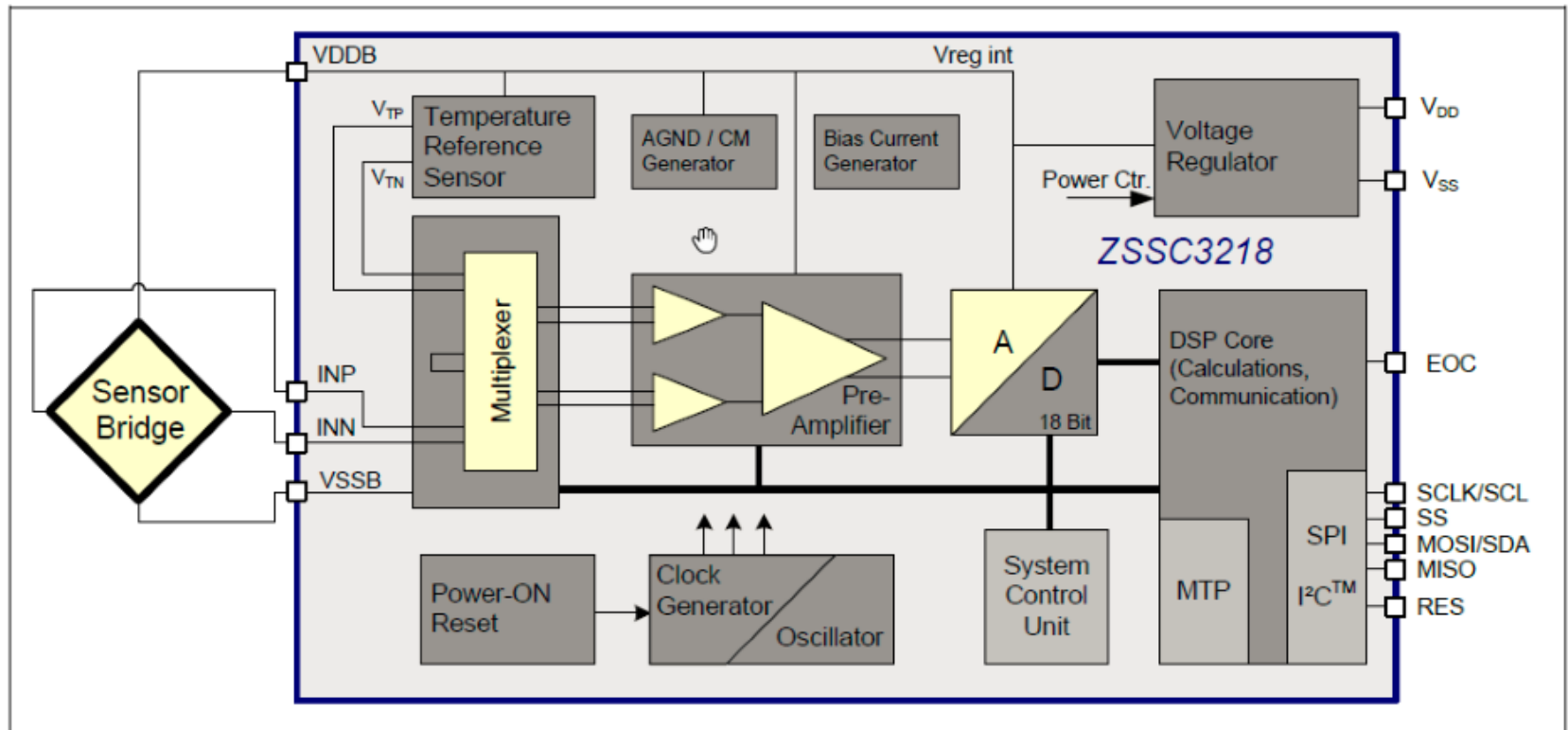


A simple condition circuit (from Internet)

- 1) ADC is not presented, as most MCU has integrated ADC;
- 2) Single end topology is in the example, differential one needs more and expensiver components;
- 3) Calibartion would be done in AP side.



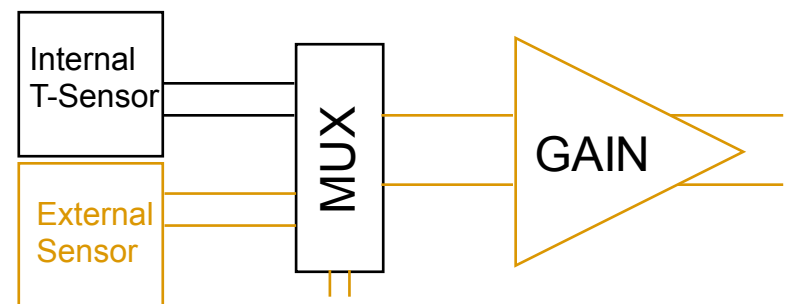
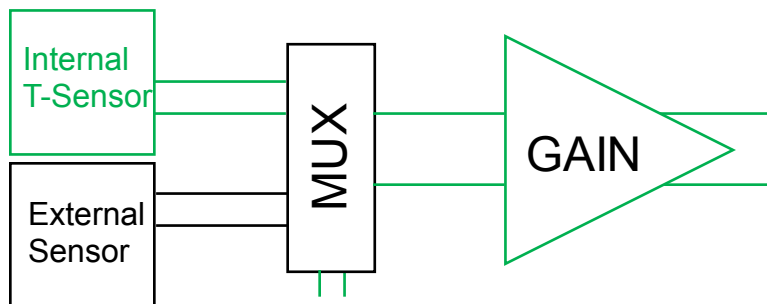
An Example of Integrated Solution_(ZSSC3218)



- Every SSC contains analog path (sensor input, multiplexer, amplifier, AD converter)
- Additionally SSCs contains other peripherals

Analog Multiplexer, Amplifier

- Each SSC contains one amplifier (consisting of one or two stages)
→ multiple measurements must be multiplexed to the amplifier
- Amplifier increases signal span of the sensor for optimal ADC input
- But bring also an additional nonlinearity to the signal



Analog Digital Converter

$$Z_{ADC} = \left(\frac{V_{IN}}{V_{REF}} + Offset \right) \cdot 2^{Resolution}$$

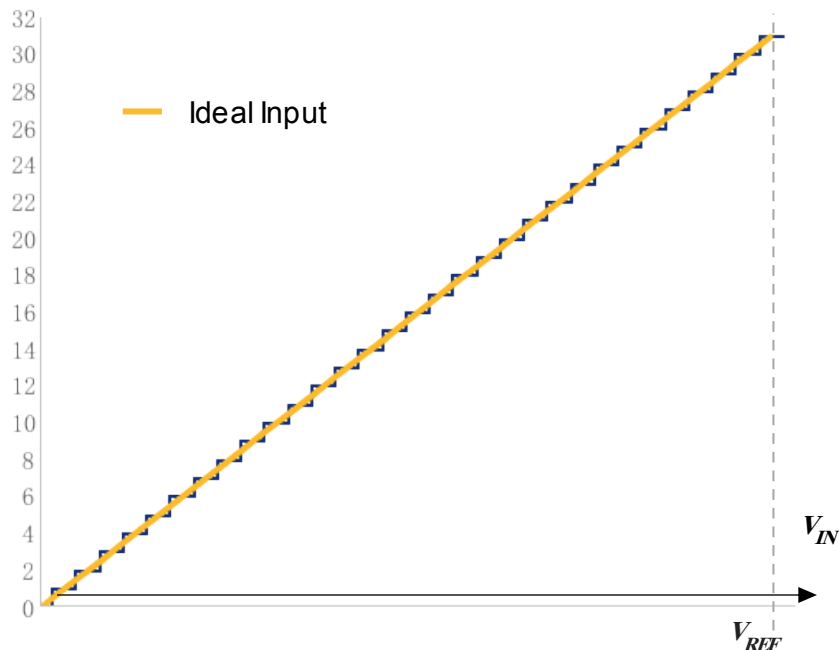
Main parameters relevant for AD conversion:

- ADC Architecture
 - CB-Charge Balancing / Sigma-Delta
- Resolution
 - Product/Configuration – depending: 9..24 Bit
- Reference Voltage
 - Ratiometric (Wheatstone bridge sensor)
 - Absolute (Temperature sensors)
- Offset
 - Compensating sensor offset voltages

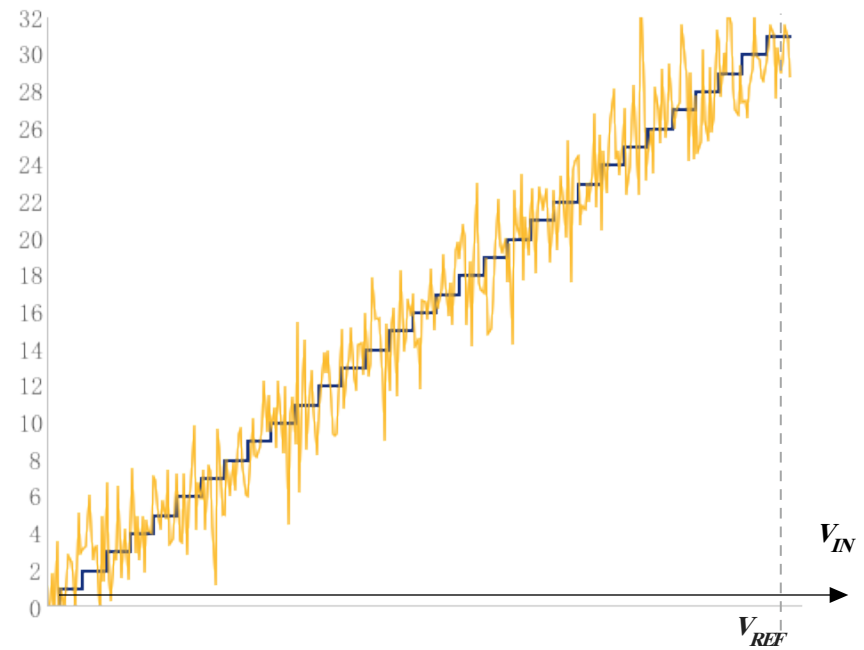
ADC Resolution

- Higher ADC-Resolution provides the option for a better digital signal quality
- Higher resolution does not mean more quality, but
- Higher resolution means more conversion time

ADC Quantization Example
(5 Bit $\rightarrow 2^5 = 32$ discrete steps)



ADC Quantization Example
(5 Bit $\rightarrow 2^5 = 32$ discrete steps)

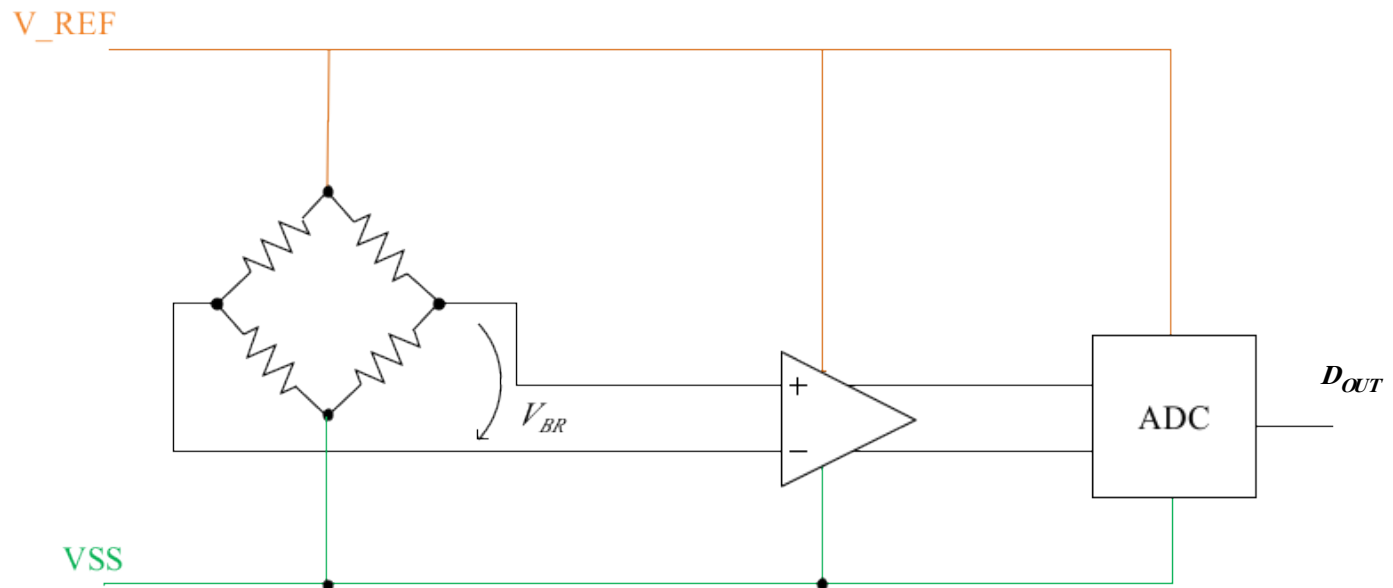


ADC Ratiometricity

- General: In a ratiometric method of measurement, the signal of interest is measured with respect to a second signal as a ratio

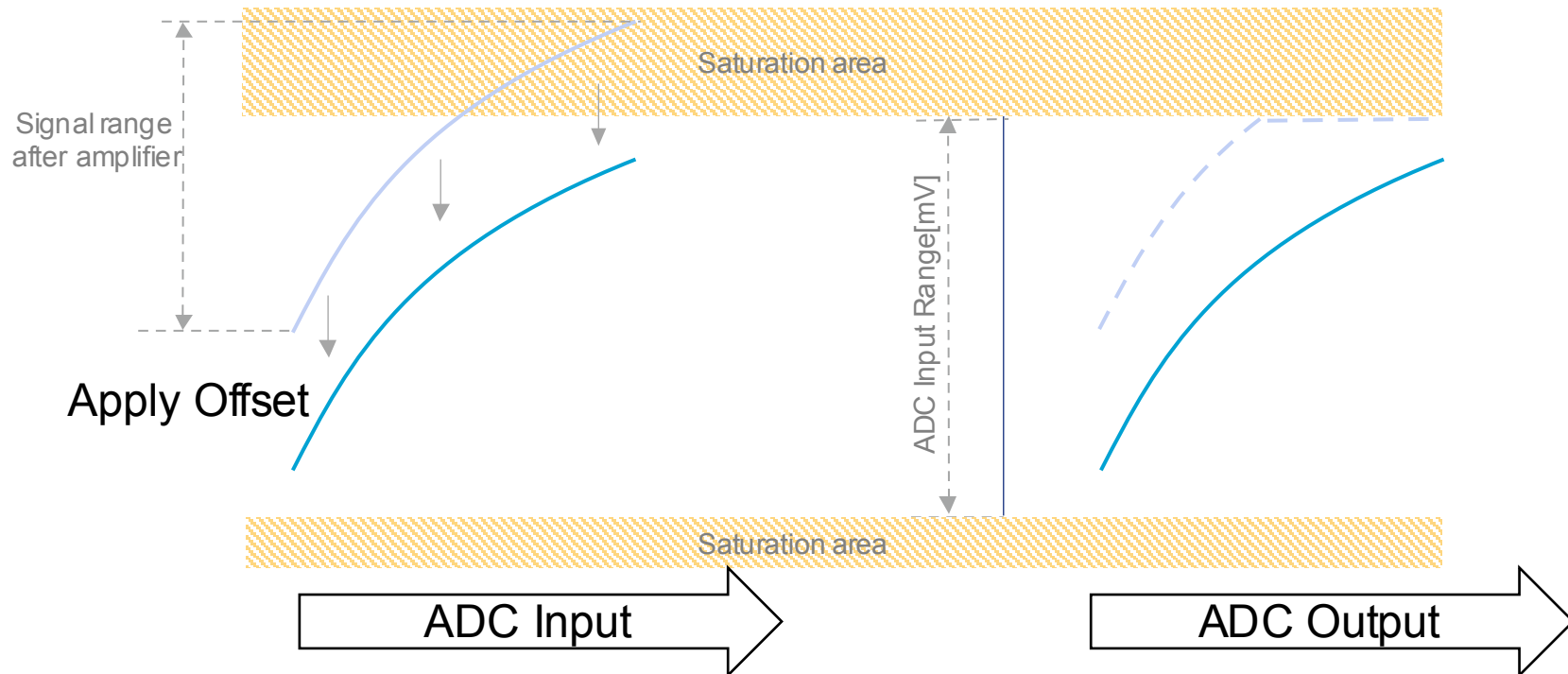
$$V_{OUT} = \frac{x}{y} V_{IN}$$

- Interferences on the V_{REF} will have affects on the Bridge Output, the amplier ouutput and teh reference volatge of the ADC
- ⇒ Variance on V_{BR} will proportionally affect ADCs digital output D_{OUT}

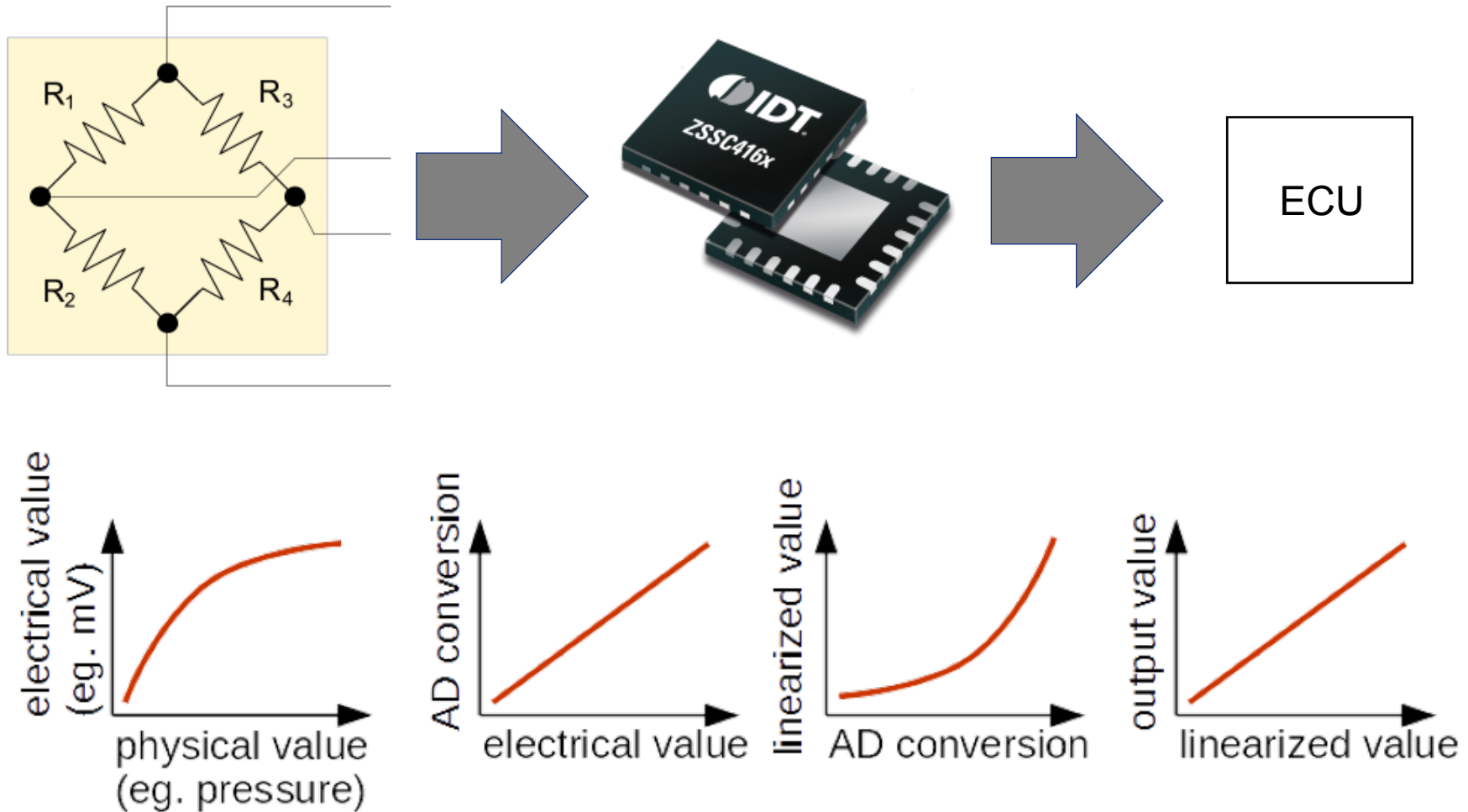


ADC Offset

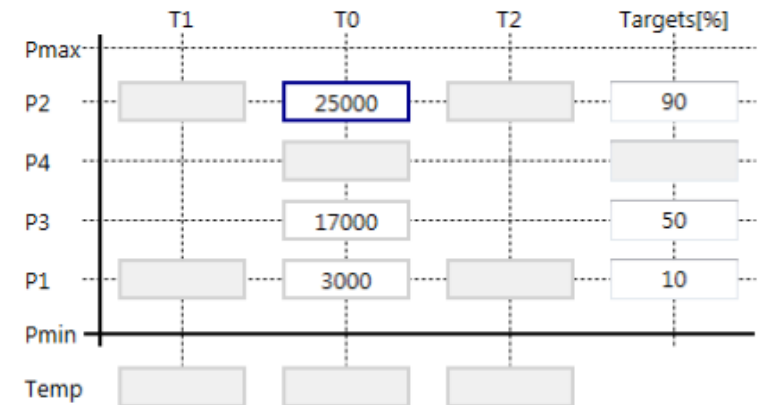
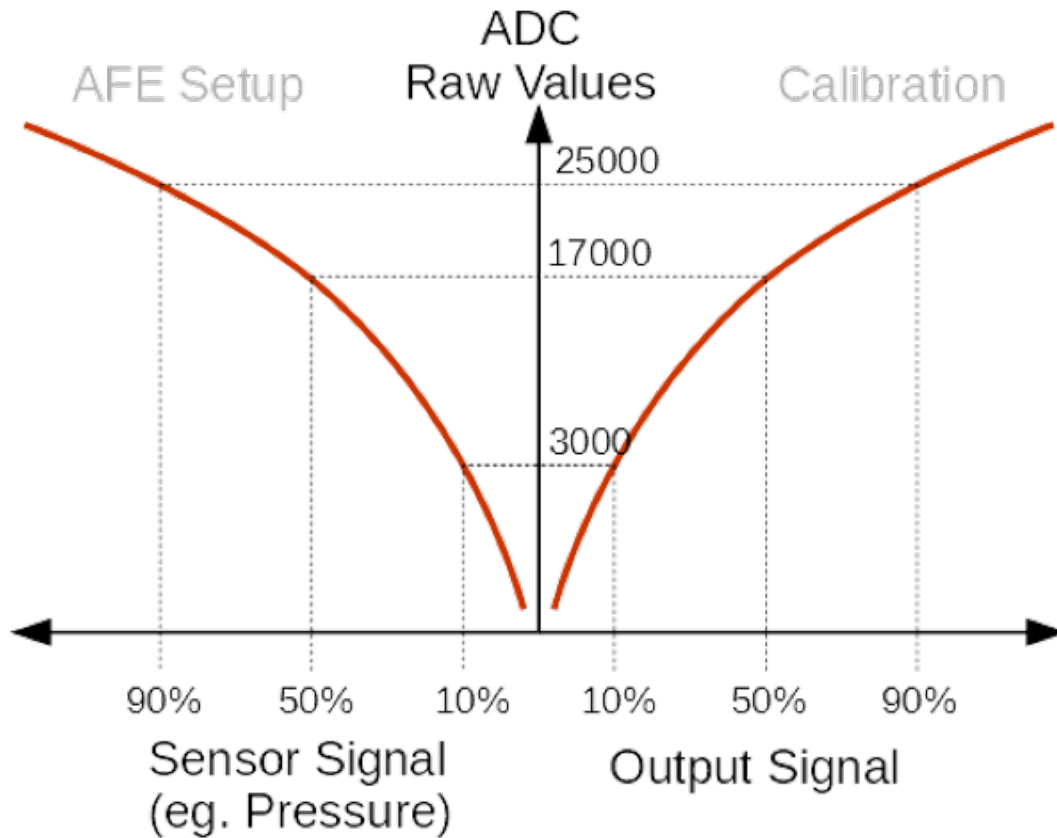
- Basically the offset is applied before ADC
- The input signal range is shifted down referring ADCs input range
- Complete sensor output is shifted
- Adjustment to ADCs Input



Calibration Theory – Transformations



Calibration Theory - Linearization



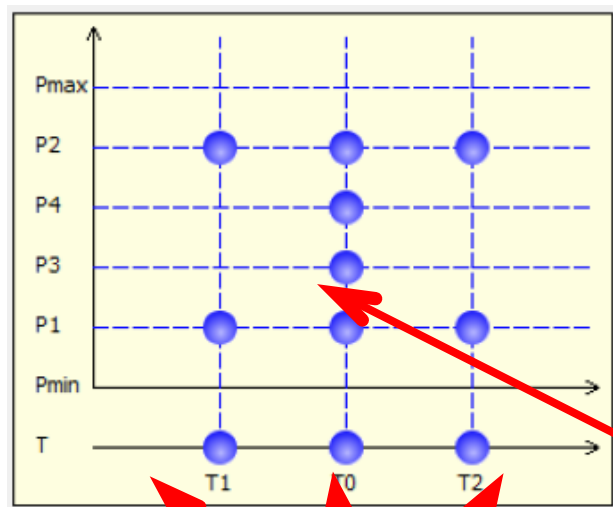
AFE Setup

- adopt sensor signal to SSC internal digital representation

Calibration

- linearize sensor signal
- scale signal to output range (eg 8/16 Bit for I²C or OWI, 12Bit for SENT, 100% for Analog)

Calibration Dialog



Acquire up to 3rd order linearization
(cubic -> 4 calibration points)

Compensate at up to three different
temperatures (2nd order)

Calibration Dialog

Calibration Type Settings

Bridge Calibrati **Cubic** ▼

Compensation **Quadratic** ▼

Select calibration method

- order of linearization
- order of compensation

Measurement data and targets

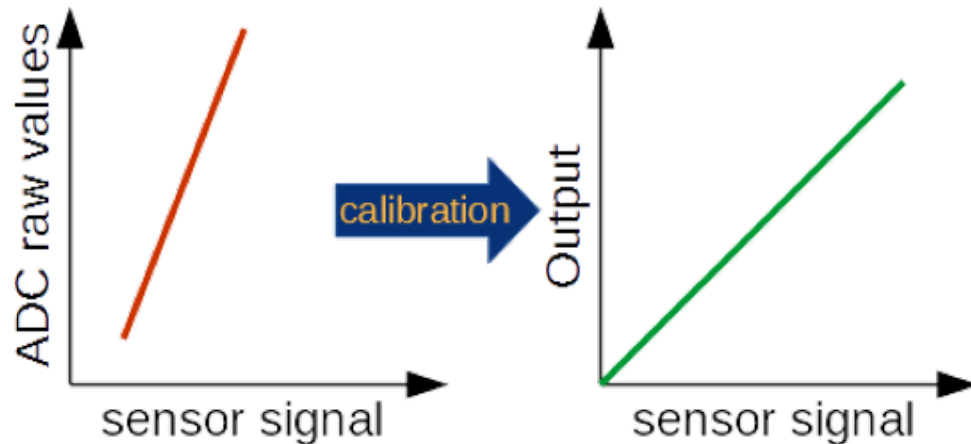
	T1	T0	T2	Targets[%]
P2	13104	12964	12776	90
P4		11572		60
P3		10166		30
P1	9712	9458	9256	10
Temp.	3027	4027	5027	

The targeted output values for the calibration points

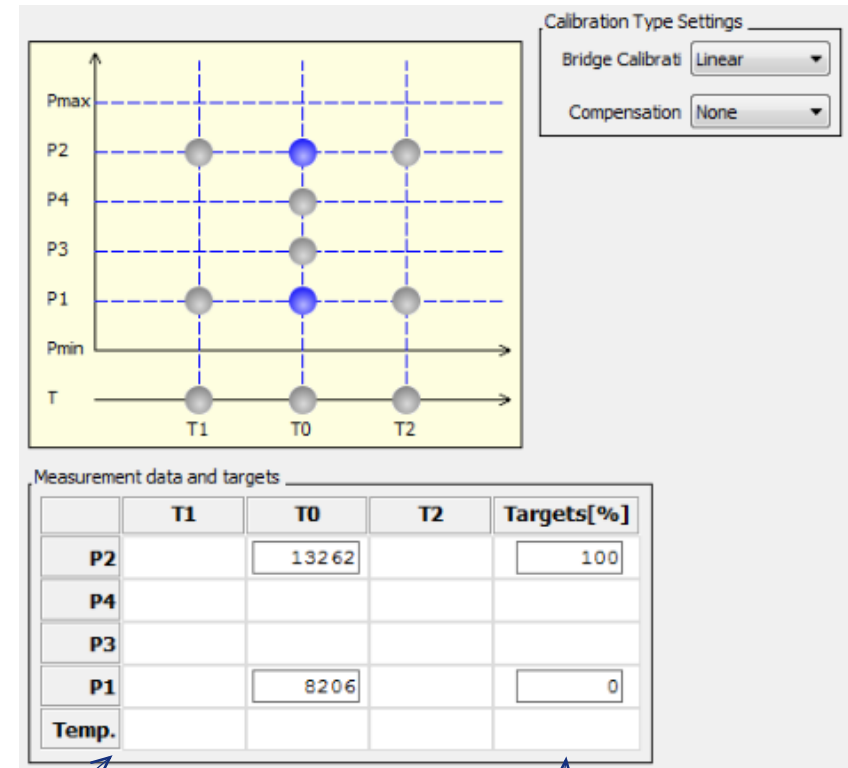
Acquire up to 3rd order linearization (cubic -> 4 calibration points)

Compensate at up to three different temperatures (2nd order)

2 Point Calibration



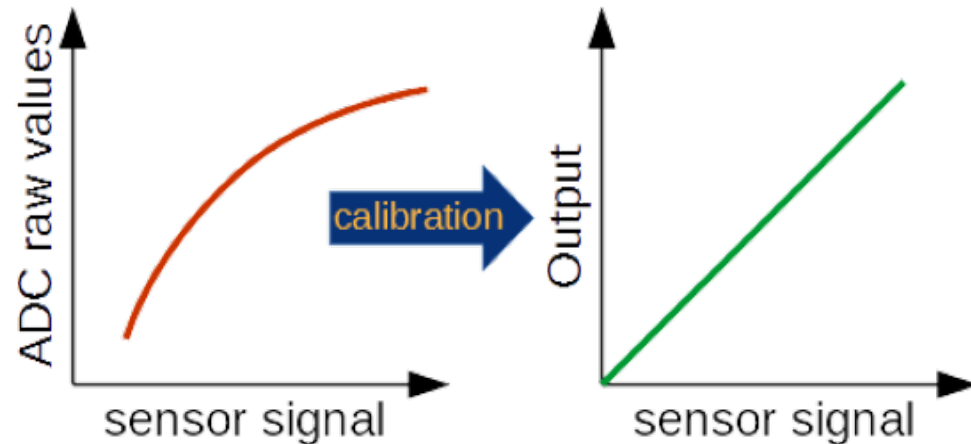
- 1st order linearization
- no temperature compensation
- just adopting gain and offset



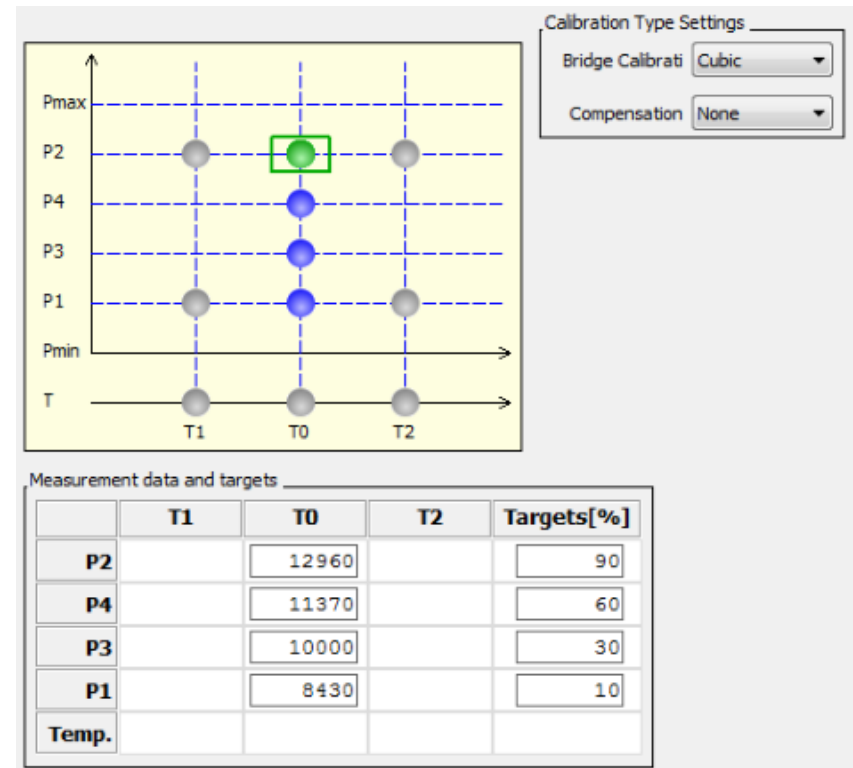
2 different pressure points
at same temperature

the targeted output
values that shall be present
at the calibration points

4 Point Calibration

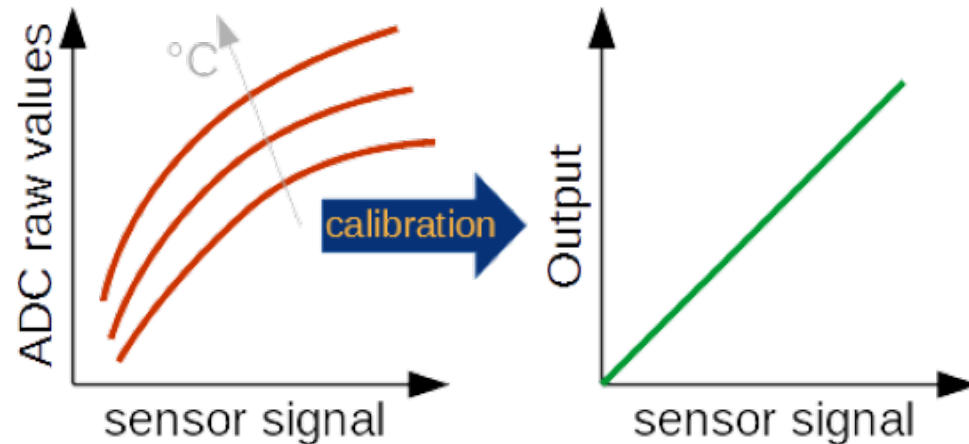


- 3rd order linearization
- no temperature compensation
- calibrate non-linearity



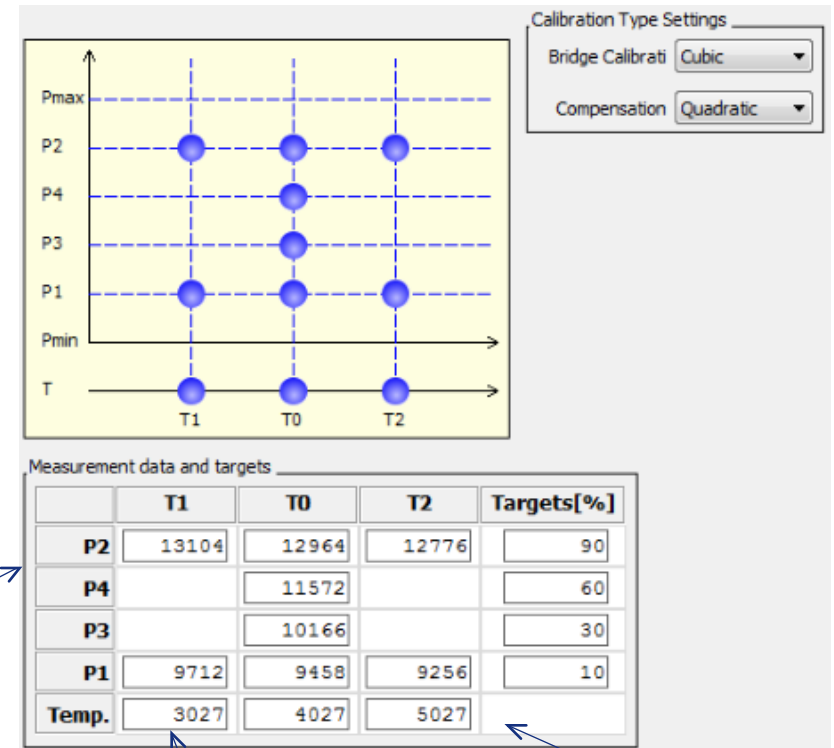
4 different pressure points
at same temperature
to calibrate non-linearity

8 Point Calibration



values in a row must be at same pressure
(but different temperature)

- 3rd order linearization
- 2nd order temperature compensation



acquire 2x same pressure
at different temperatures
for compensation

different
temperature
points

The Comparations on Two Solutions

Items	Discrete solution	Integrated solution(1)	Note
Flexibility	Less	Configurable	the SSC profile in datasheet
BOM cost	lower	Higher	Material cost of SSC module
Assemble cost	High	Low	PCB size, aux components
Invisible cost	High	Low	Design, debug, quality(2), etc.
Consistency	low	High	Part to part, batch to batch
Performance	low	High	Linearity, noise level, etc.
Robustness	low	High	Stability, EMC, etc.

- 1) Take IDT SSC device for example here;
- 2) The discrte solution can be adjusted by different combination of components and their parameters, but the the general topology is fixed once the Gerber is taped out;
- 3) Might make side effect to after sale service, and brand reputation.



Thank You

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Leadership in Growth Markets